TOSHIBA

INTEGRATED CIRCUIT

TECHNICAL DATA

TOSHIBA MOS DIGITAL INTEGRATED CIRCUIT
TC514280BJ/BZ/BFT/BTR-70
TC514280BJ/BZ/BFT/BTR-80
TC514280BJ/BZ/BFT/BTR-10
SILICON GATE CMOS

TENTATIVE DATA

262,144 WORD × 18 BIT DYNAMIC RAM

DESCRIPTION

The TC514280BJ/BZ/BFT/BTR is the new generation dynamic RAM organized 262,144 words by 18 bits. The TC514280BJ/BZ/BFT/BTR utilizes TOSHIBA's CMOS Silicon gate process technology as well as advanced circuit techniques to provide wide operating margins, both internally and to the system user. Multiplexed address inputs permit the TC514280BJ/BZ/BFT/BTR to be packaged in a standard 40 pin plastic SOJ, 40 pin plastic ZIP and 44/40 pin plastic TSOP. The package size provides high system bit densities and is compatible with widely available automated testing and insertion equipment. System oriented features include single power supply of 5V±10% tolerance, direct interfacing capability with high performance logic families such as Schottky TTL.

FEATURES

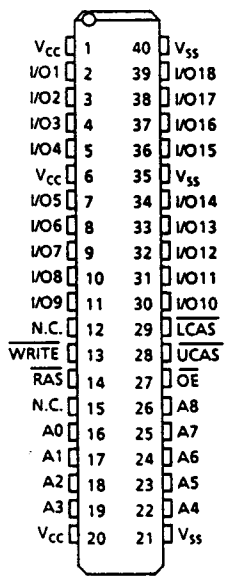
- 262,144 word by 18 bit organization
- Fast access time and cycle time

		TC514280BJ/BZ/BFT/BTR		
		-70	-80	-10
t_{RAC}	$\overline{RAS}$ Access Time	70ns	80ns	100ns
t_{AA}	Column Address Access Time	35ns	40ns	50ns
t_{CAC}	$\overline{CAS}$ Access Time	20ns	20ns	25ns
t_{RC}	Cycle Time	130ns	150ns	180ns
t_{PC}	Fast Page Mode Cycle Time	45ns	50ns	60ns

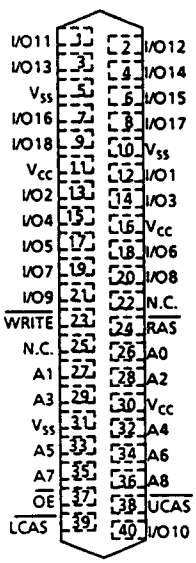
- Single power supply of 5V±10% with a built-in V_{BB} generator
- Low Power
  605mW MAX. Operating (TC514280BJ/BZ/BFT/BTR-70)
  523mW MAX. Operating (TC514280BJ/BZ/BFT/BTR-80)
  468mW MAX. Operating (TC514280BJ/BZ/BFT/BTR-10)
  5.5mW MAX. Standby
- Outputs unlatched at cycle end allows two-dimensional chip selection
- Read-Modify-Write, $\overline{CAS}$ before $\overline{RAS}$ refresh, $\overline{RAS}$-only refresh, Hidden refresh and Fast Page Mode capability
- All inputs and outputs TTL compatible
- 512 refresh cycles/8ms
- Package TC514280BJ : SOJ40-P-400
  TC514280BZ : ZIP40-P-475
  TC514280BFT : TSOP44-P-400B
  TC514280BTR : TSOP44-P-400C

PIN CONNECTION (TOP VIEW)

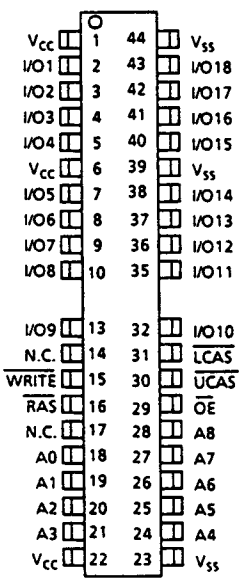
Plastic SOJ



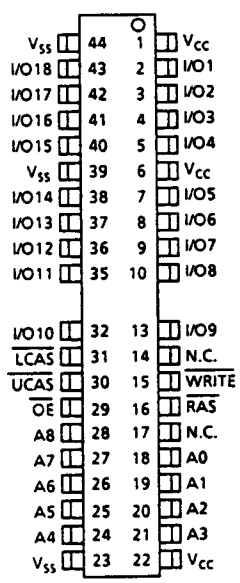
Plastic ZIP



Plastic TSOP (Normal Bend Type)



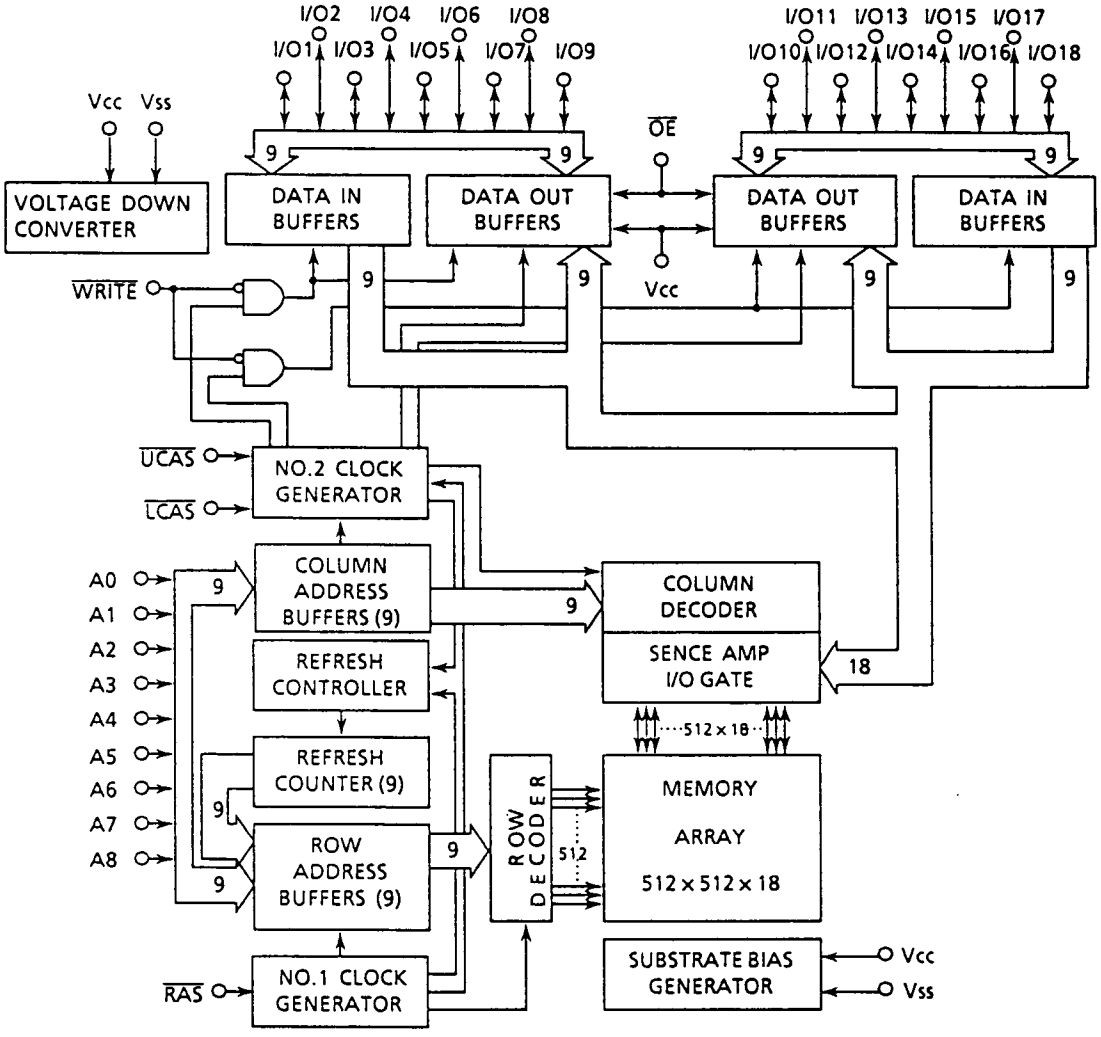
Plastic TSOP (Reverse Bend Type)



PIN NAMES

A0~A8	Address Inputs
$\overline{RAS}$	Row Address Strobe
$\overline{UCAS}$	Column Address Strobe/Upper Byte Control
$\overline{LCAS}$	Column Address Strobe/Lower Byte Control
$\overline{WRITE}$	Read/Write Input
$\overline{OE}$	Output Enable
I/O1~ I/O18	Data Input/Output
V_{CC}	Power (+5V)
V_{SS}	Ground
N.C.	No Connection

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	RATING	UNIT	NOTE
Input Voltage	V_{IN}	−1~7	V	1
Output Voltage	V_{OUT}	−1~7	V	1
Power Supply Voltage	V_{CC}	−1~7	V	1
Operating Temperature	T_{OPR}	0~70	°C	1
Storage Temperature	T_{STG}	−55~150	°C	1
Soldering Temperature · Time	T_{SOLDER}	260 · 10	°C · sec	1
Power Dissipation	P_D	700	mW	1
Short Circuit Output Current	I_{OUT}	50	mA	1

RECOMMENDED DC OPERATING CONDITIONS (Ta = 0~70°c)

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT	NOTE
V_{CC}	Supply Voltage	4.5	5.0	5.5	V	2
V_{IH}	Input High Voltage	2.4	−	V_{CC} + 0.5	V	2
V_{IL}	Input Low Voltage	−0.5*	−	0.8	V	2

* −2.0 V at pulse width ≦ 20ns

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5V ± 10%, Ta = 0~70°c)

SYMBOL	PARAMETER		MIN.	MAX.	UNIT	NOTE
I_{CC1}	OPERATING CURRENT Average Power Supply Operating Current ($\overline{RAS}$, $\overline{UCAS}$, $\overline{LCAS}$, Address Cycling: $t_{RC} = t_{RC}$ MIN.)	TC514280BJ/BZ/BFT/BTR-70	–	110	mA	3, 4, 5
		TC514280BJ/BZ/BFT/BTR-80	–	95		
		TC514280BJ/BZ/BFT/BTR-10	–	85		
I_{CC2}	STANDBY CURRENT Power Supply Standby Current ($\overline{RAS} = \overline{UCAS} = \overline{LCAS} = V_{IH}$)		–	2	mA	
I_{CC3}	$\overline{RAS}$ ONLY REFRESH CURRENT Average Power Supply Current, $\overline{RAS}$ Only Mode ($\overline{RAS}$ Cycling, $\overline{UCAS} = \overline{LCAS} = V_{IH}$: $t_{RC} = t_{RC}$ MIN.)	TC514280BJ/BZ/BFT/BTR-70	–	110	mA	3, 5
		TC514280BJ/BZ/BFT/BTR-80	–	95		
		TC514280BJ/BZ/BFT/BTR-10	–	85		
I_{CC4}	FAST PAGE MODE CURRENT Average Power Supply Current, Fast Page Mode ($\overline{RAS} = V_{IL}$, $\overline{UCAS}$, $\overline{LCAS}$, Address Cycling: $t_{PC} = t_{PC}$ MIN.)	TC514280BJ/BZ/BFT/BTR-70	–	80	mA	3, 4, 5
		TC514280BJ/BZ/BFT/BTR-80	–	70		
		TC514280BJ/BZ/BFT/BTR-10	–	65		
I_{CC5}	STANDBY CURRENT Power Supply Standby Current ($\overline{RAS} = \overline{UCAS} = \overline{LCAS} = V_{CC} - 0.2V$)		–	1	mA	
I_{CC6}	$\overline{CAS}$ BEFORE $\overline{RAS}$ REFRESH CURRENT Average Power Supply Current, $\overline{CAS}$ Before $\overline{RAS}$ Mode ($\overline{RAS}$, $\overline{UCAS}$, $\overline{LCAS}$ Cycling: $t_{RC} = t_{RC}$ MIN.)	TC514280BJ/BZ/BFT/BTR-70	–	110	mA	3, 5
		TC514280BJ/BZ/BFT/BTR-80	–	95		
		TC514280BJ/BZ/BFT/BTR-10	–	85		
$I_{I(L)}$	INPUT LEAKAGE CURRENT Input Leakage Current, any input ($0V \leq V_{IN} \leq V_{CC}$, All Other Pins Not Under Test = 0V)		– 10	10	μA	
$I_{O(L)}$	OUTPUT LEAKAGE CURRENT (D_{OUT} is disabled, $0V \leq V_{OUT} \leq V_{CC}$)		– 10	10	μA	
V_{OH}	OUTPUT LEVEL Output "H" Level Voltage (I_{OUT} = – 5mA)		2.4	–	V	
V_{OL}	OUTPUT LEVEL Output "L" Level Voltage (I_{OUT} = 4.2mA)		–	0.4	V	

ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS

(V_{CC} = 5V ± 10%, Ta = 0~70°c) (Notes 6, 7, 8)

SYMBOL	PARAMETER	TC514280BJ/BZ/BFT/BTR						UNIT	NOTE
		-70		-80		-10			
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
t_{RC}	Random Read or Write Cycle Time	130	–	150	–	180	–	ns	
t_{RMW}	Read-Modify-Write Cycle Time	185	–	205	–	245	–	ns	
t_{PC}	Fast Page Mode Cycle Time	45	–	50	–	60	–	ns	
t_{PRMW}	Fast Page Mode Read-Modify-Write Cycle Time	100	–	105	–	125	–	ns	
t_{RAC}	Access Time from $\overline{RAS}$	–	70	–	80	–	100	ns	9,14, 15
t_{CAC}	Access Time from $\overline{CAS}$	–	20	–	20	–	25	ns	9,14
t_{AA}	Access Time from Column Address	–	35	–	40	–	50	ns	9,15
t_{CPA}	Access Time from $\overline{CAS}$ Precharge	–	40	–	45	–	55	ns	9
t_{CLZ}	$\overline{CAS}$ to output in Low-Z	0	–	0	–	0	–	ns	9
t_{OFF}	Output Buffer Turn-off Delay	0	15	0	15	0	20	ns	10
t_T	Transition Time (Rise and Fall)	3	50	3	50	3	50	ns	
t_{RP}	$\overline{RAS}$ Precharge Time	50	–	60	–	70	–	ns	
t_{RAS}	$\overline{RAS}$ Pulse Width	70	10,000	80	10,000	100	10,000	ns	
t_{RASP}	$\overline{RAS}$ Pulse Width (Fast Page Mode)	70	100,000	80	100,000	100	100,000	ns	
t_{RSH}	$\overline{RAS}$ Hold Time	20	–	20	–	25	–	ns	
t_{RHCP}	$\overline{RAS}$ Hold Time From $\overline{CAS}$ Precharge (Fast Page Mode)	40	–	45	–	55	–	ns	
t_{CSH}	$\overline{CAS}$ Hold Time	70	–	80	–	100	–	ns	
t_{CAS}	$\overline{CAS}$ Pulse Width	20	10,000	20	10,000	25	10,000	ns	
t_{RCD}	$\overline{RAS}$ to $\overline{CAS}$ Delay Time	20	50	20	60	25	75	ns	14
t_{RAD}	$\overline{RAS}$ to Column Address Delay Time	15	35	15	40	20	50	ns	15
t_{CRP}	$\overline{CAS}$ to $\overline{RAS}$ Precharge Time	5	–	5	–	10	–	ns	
t_{CP}	$\overline{CAS}$ Precharge Time	10	–	10	–	10	–	ns	
t_{ASR}	Row Address Set-Up Time	0	–	0	–	0	–	ns	
t_{RAH}	Row Address Hold Time	10	–	10	–	15	–	ns	
t_{ASC}	Column Address Set-Up Time	0	–	0	–	0	–	ns	
t_{CAH}	Column Address Hold Time	15	–	15	–	20	–	ns	
t_{RAL}	Column Address to $\overline{RAS}$ Lead Time	35	–	40	–	50	–	ns	
t_{RCS}	Read Command Set-Up Time referenced to $\overline{RAS}$	0	–	0	–	0	–	ns	
t_{RCH}	Read Command Hold Time	0	–	0	–	0	–	ns	11
t_{RRH}	Read Command Hold Time referenced to $\overline{RAS}$	0	–	0	–	0	–	ns	11
t_{WCH}	Write Command Hold Time	15	–	15	–	20	–	ns	

ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS (Continued)

SYMBOL	PARAMETER	TC514280BJ/BZ/BFT/BTR						UNIT	NOTE
		-70		-80		-10			
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
t_{WP}	Write Command Pulse Width	15	–	15	–	20	–	ns	
t_{RWL}	Write Command to $\overline{RAS}$ Lead Time	20	–	20	–	25	–	ns	
t_{CWL}	Write Command to $\overline{CAS}$ Lead Time	20	–	20	–	25	–	ns	
t_{DS}	Data Set-Up Time	0	–	0	–	0	–	ns	12
t_{DH}	Data Hold Time	15	–	15	–	20	–	ns	12
t_{REF}	Refresh Period	–	8	–	8	–	8	ms	
t_{WCS}	Write Command Set-Up Time	0	–	0	–	0	–	ns	13
t_{CWD}	$\overline{CAS}$ to $\overline{WRITE}$ Delay Time	50	–	50	–	60	–	ns	13
t_{RWD}	$\overline{RAS}$ to $\overline{WRITE}$ Delay Time	100	–	110	–	135	–	ns	13
t_{AWD}	Column Address to $\overline{WRITE}$ Delay Time	65	–	70	–	85	–	ns	13
t_{CPWD}	$\overline{CAS}$ Precharge to $\overline{WRITE}$ Delay Time	70	–	75	–	90	–	ns	13
t_{CSR}	$\overline{CAS}$ Set-Up Time ($\overline{CAS}$ before $\overline{RAS}$ Cycle)	5	–	5	–	5	–	ns	
t_{CHR}	$\overline{CAS}$ Hold Time ($\overline{CAS}$ before $\overline{RAS}$ Cycle)	15	–	15	–	20	–	ns	
t_{RPC}	$\overline{RAS}$ to $\overline{CAS}$ Precharge Time	5	–	5	–	5	–	ns	
t_{CPT}	$\overline{CAS}$ Precharge Time ($\overline{CAS}$ before $\overline{RAS}$ Counter Test Cycle)	30	–	30	–	40	–	ns	
t_{ROH}	$\overline{RAS}$ Hold Time referenced to $\overline{OE}$	10	–	10	–	20	–	ns	
t_{OEA}	$\overline{OE}$ Access Time	–	20	–	20	–	25	ns	9
t_{OED}	$\overline{OE}$ to Data Delay	20	–	20	–	25	–	ns	
t_{OEZ}	Output buffer turn off Delay Time from $\overline{OE}$	0	20	0	20	0	25	ns	10
t_{OEH}	$\overline{OE}$ Command Hold Time	20	–	20	–	25	–	ns	
t_{ODS}	Output Disable Set-Up Time	0	–	0	–	0	–	ns	

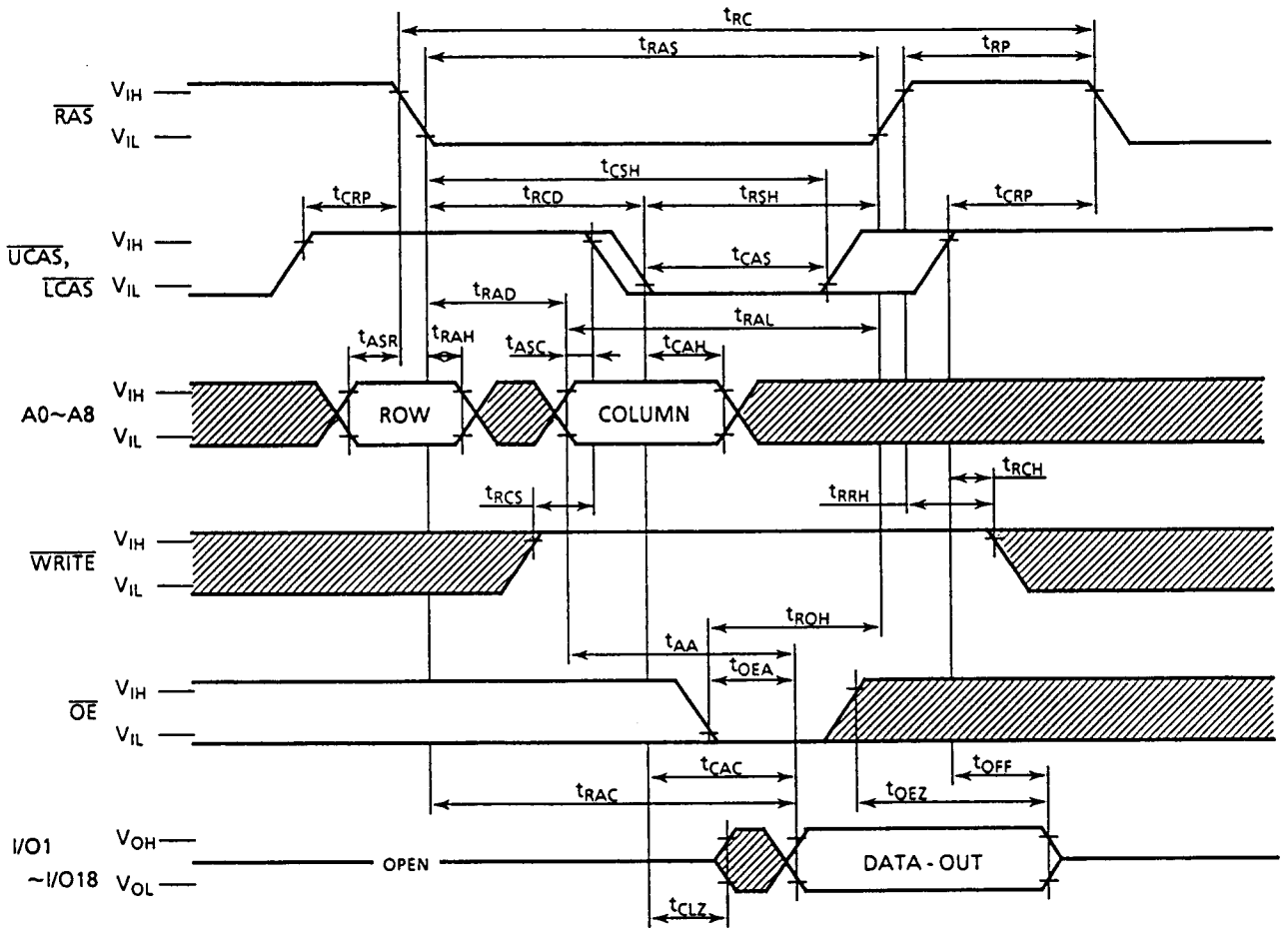
CAPACITANCE (V_{CC} = 5V ± 10%, f = 1MHz, Ta = 0~70°c)

SYMBOL	CHARACTERISTIC	MIN.	MAX.	UNIT
C_{I1}	Input Capacitance (A0~A8)	–	5	pF
C_{I2}	Input Capacitance ($\overline{RAS}$, $\overline{UCAS}$, $\overline{LCAS}$, $\overline{WRITE}$, $\overline{OE}$)	–	7	pF
C_O	Input/Output Capacitance (I/O1~I/O18)	–	7	pF

NOTES:

1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.
2. All voltages are referenced to V_{SS}.
3. I_{CC1}, I_{CC3}, I_{CC4}, I_{CC6} depend on cycle rate.
4. I_{CC1}, I_{CC4} depend on output loading. Specified values are obtained with the output open.
5. Address can be changed once or less while $\overline{RAS}=V_{IL}$. In case of Icc4, it can be changed once or less during a fast page mode cycle (tPC).
6. An initial pause of 200μs is required after power-up followed by 8 $\overline{RAS}$ only refresh cycles before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8 $\overline{CAS}$ before $\overline{RAS}$ refresh cycles instead of 8 $\overline{RAS}$ only refresh cycles are required.
7. AC measurements assume $t_T=5$ns.
8. V_{IH} (min.) and V_{IL} (max.) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} and V_{IL}.
9. Measured with a load equivalent to 2 TTL loads and 100pF.
10. t_{OFF} (max.) and t_{OEZ} (max.) define the time at which the output achieves the open circuit condition and are not referenced to output voltage levels.
11. Either t_{RCH} or t_{RRH} must be satisfied for a read cycle.
12. These parameters are referenced to $\overline{UCAS}$, $\overline{LCAS}$ leading edge in early write cycles and to $\overline{WRITE}$ leading edge in Read-Modify-Write cycles.
13. t_{WCS}, t_{RWD}, t_{CWD}, t_{AWD} and t_{CPWD} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only. If $t_{WCS} \geqq t_{WCS}$ (min.), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) through the entire cycle; If $t_{RWD} \geqq t_{RWD}$ (min.), $t_{CWD} \geqq t_{CWD}$ (min.), $t_{AWD} \geqq t_{AWD}$ (min.) and $t_{CPWD} \geqq t_{CPWD}$ (min.) (Fast Page Mode), the cycle is a Read-Modify-Write cycle and the data out will contain data read from the selected cell: If neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
14. Operation within the t_{RCD} (max.) limit insures that t_{RAC} (max.) can be met. t_{RCD} (max.) is specified as a reference point only: If t_{RCD} is greater than the specified t_{RCD} (max.) limit, then access time is controlled by t_{CAC}.
15. Operation within the t_{RAD} (max.) limit insures that t_{RAC} (max.) can be met. t_{RAD} (max.) is specified as a reference point only: If t_{RAD} is greater than the specified t_{RAD} (max.) limit, then access time is controlled by t_{AA}.

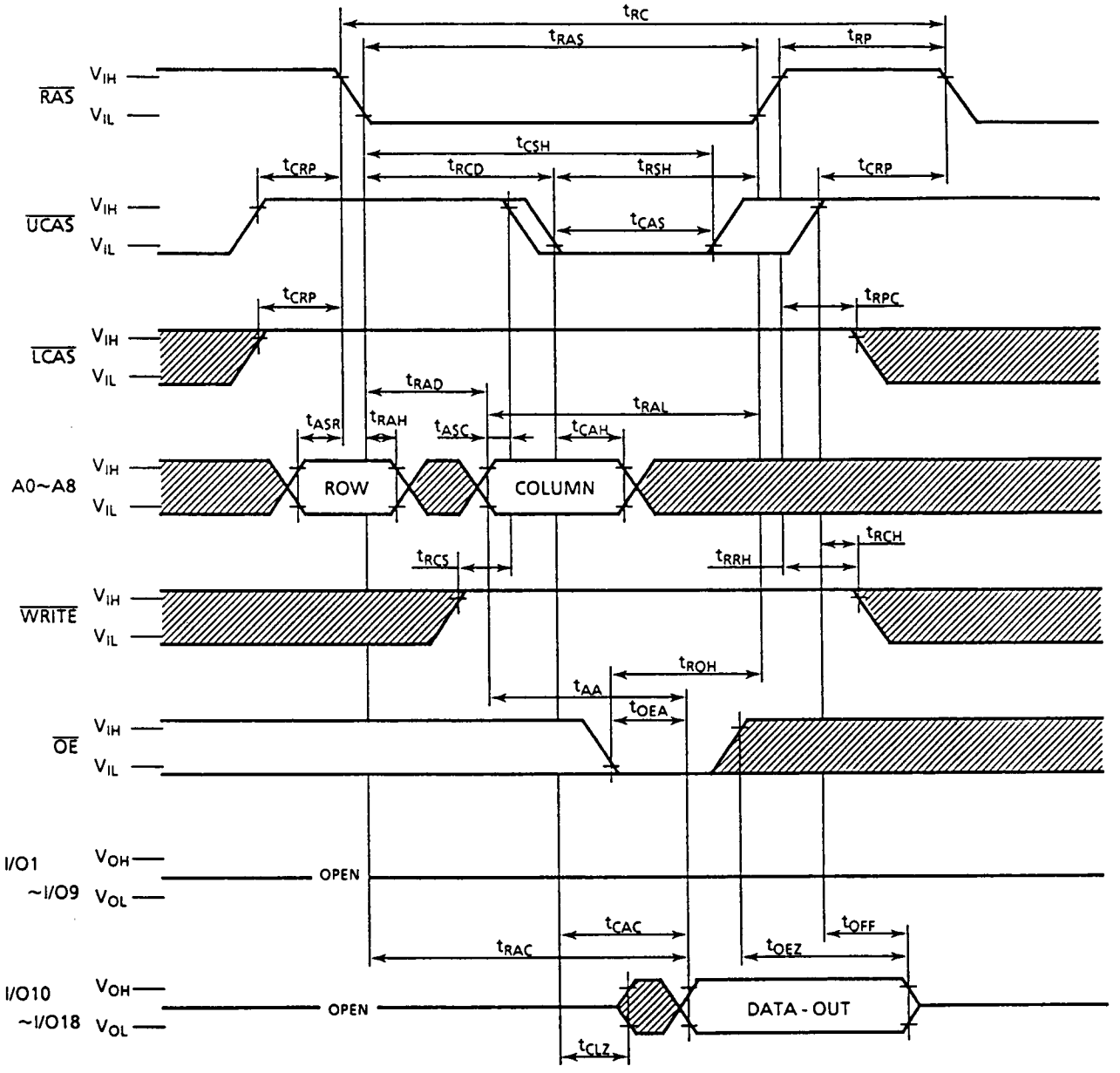
READ CYCLE



Note: D_{IN} = OPEN

▨ : "H" or "L"

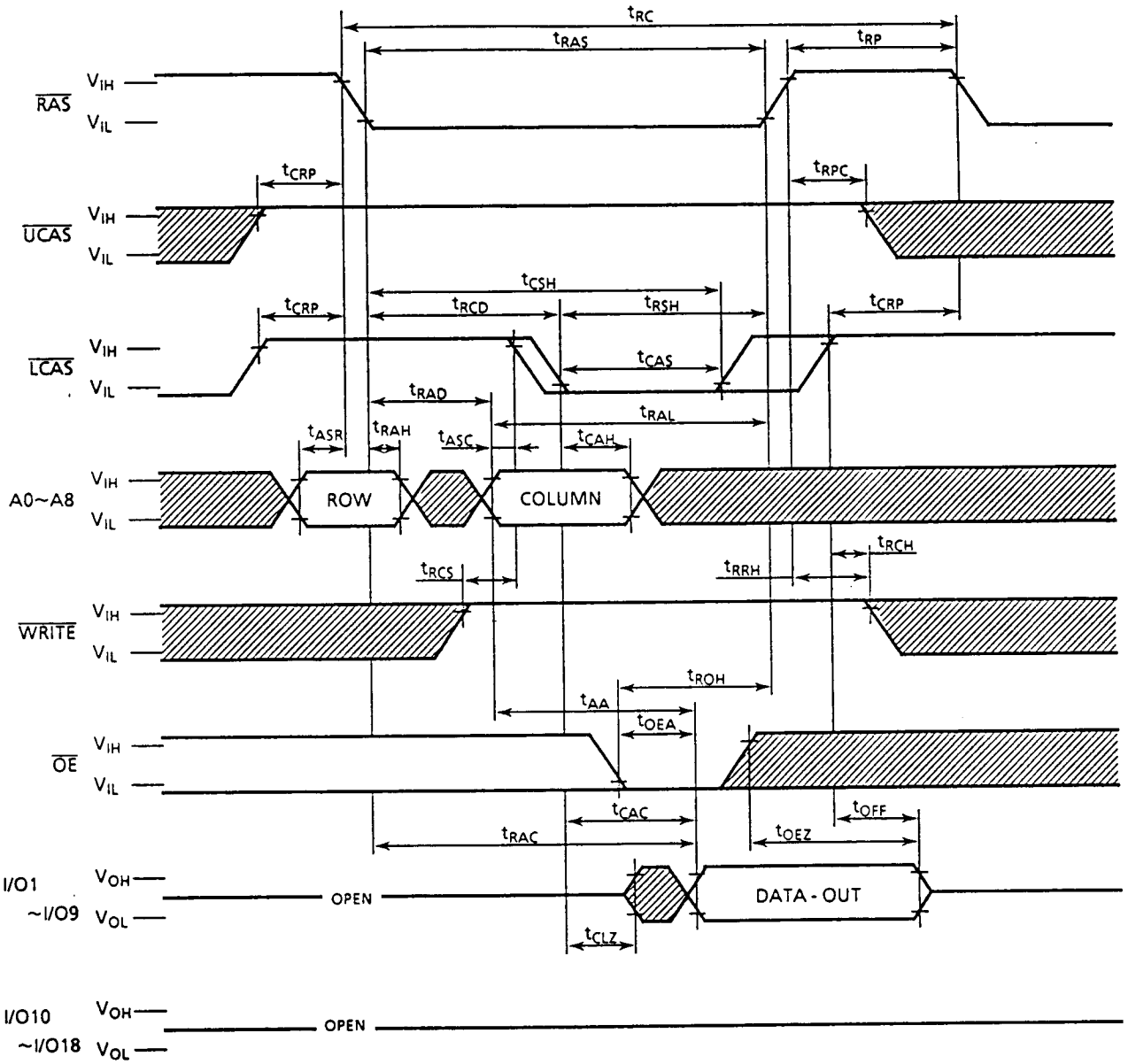
UPPER BYTE READ CYCLE



Note: D_{IN} (I/O1~I/O9) = Don't Care
D_{IN} (I/O10~I/O18) = OPEN

▨ : "H" or "L"

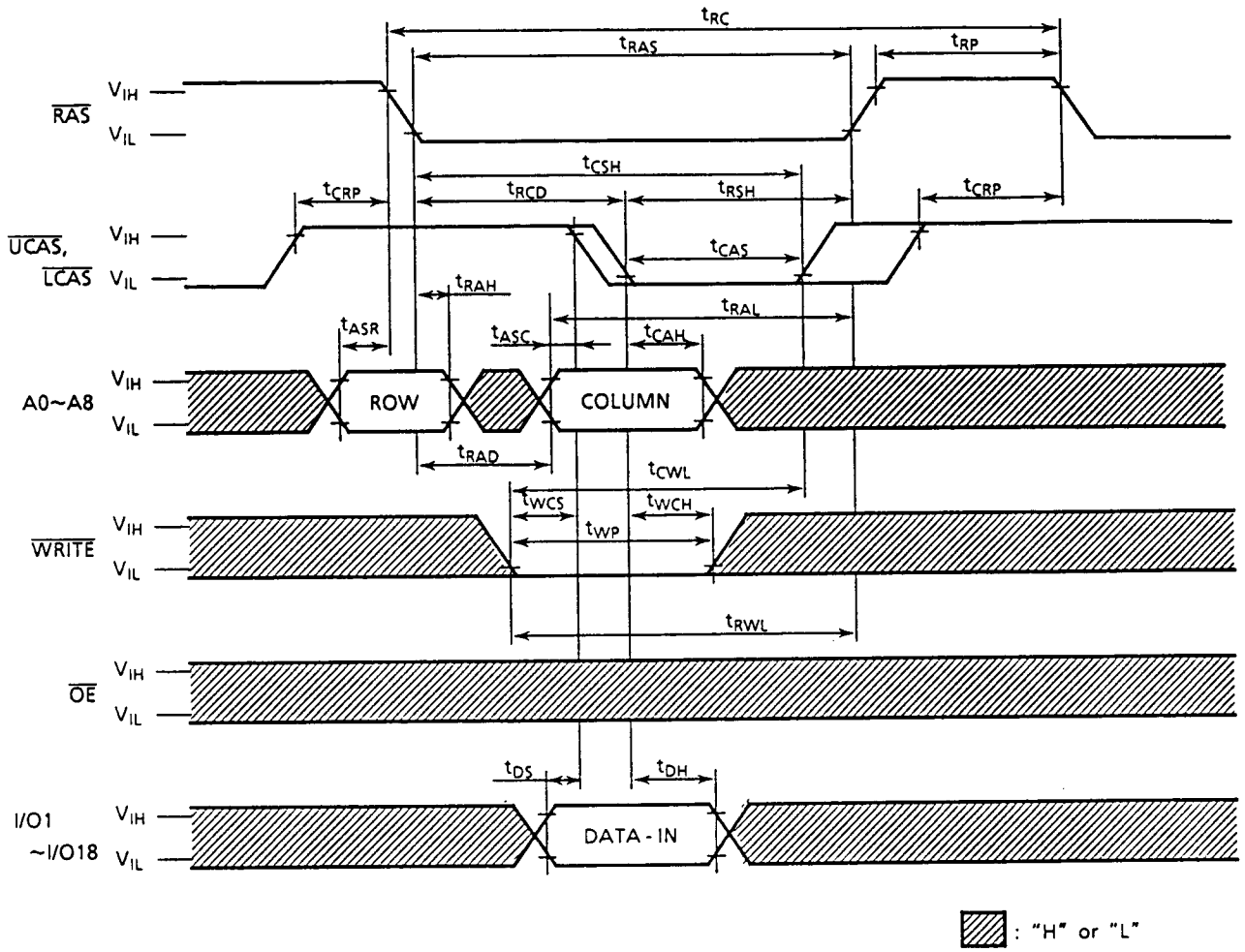
LOWER BYTE READ CYCLE



Note: D_{IN} (I/O1~I/O9) = OPEN
D_{IN} (I/O10~I/O18) = Don't Care

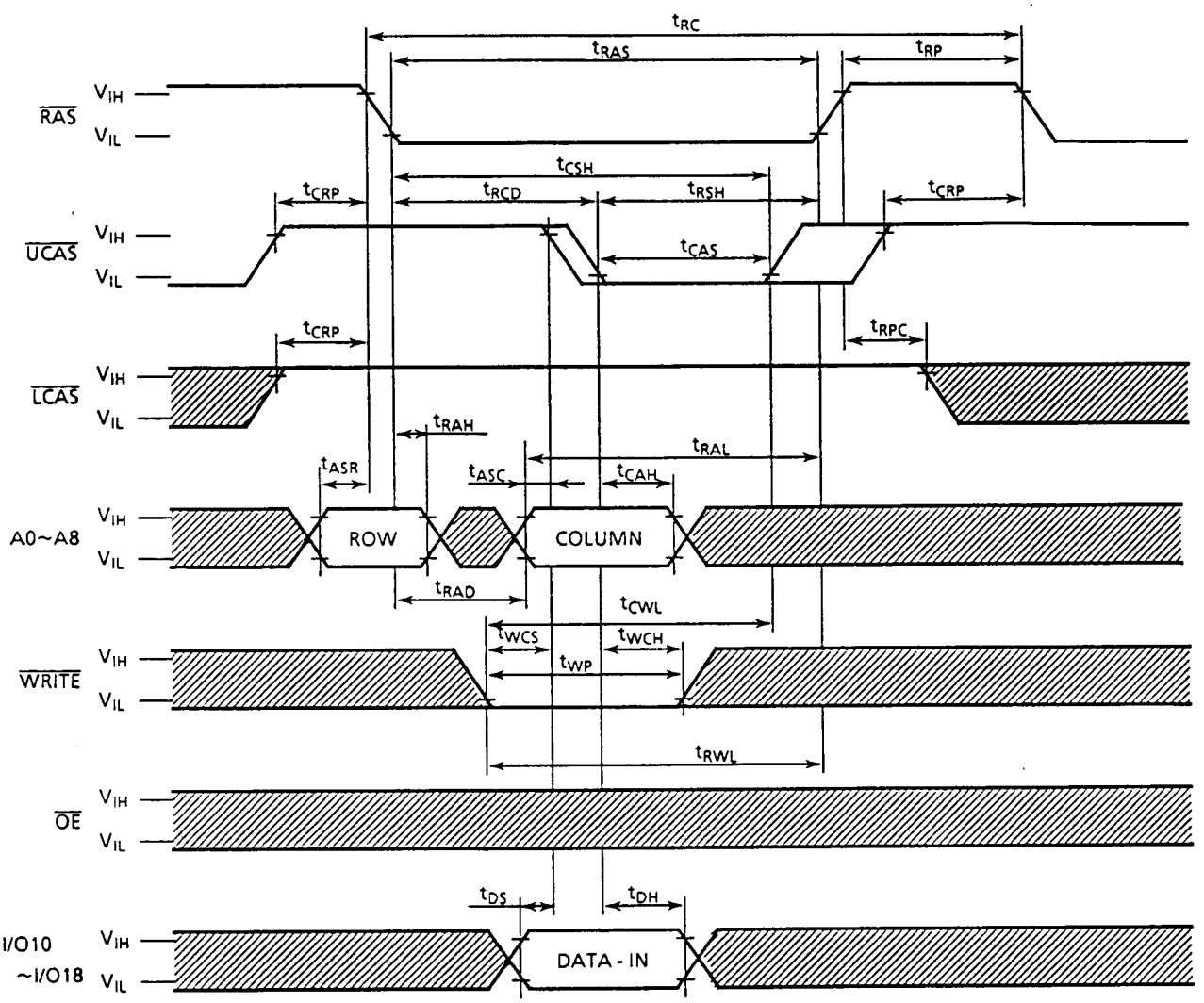
▨ : "H" or "L"

WRITE CYCLE (EARLY WRITE)



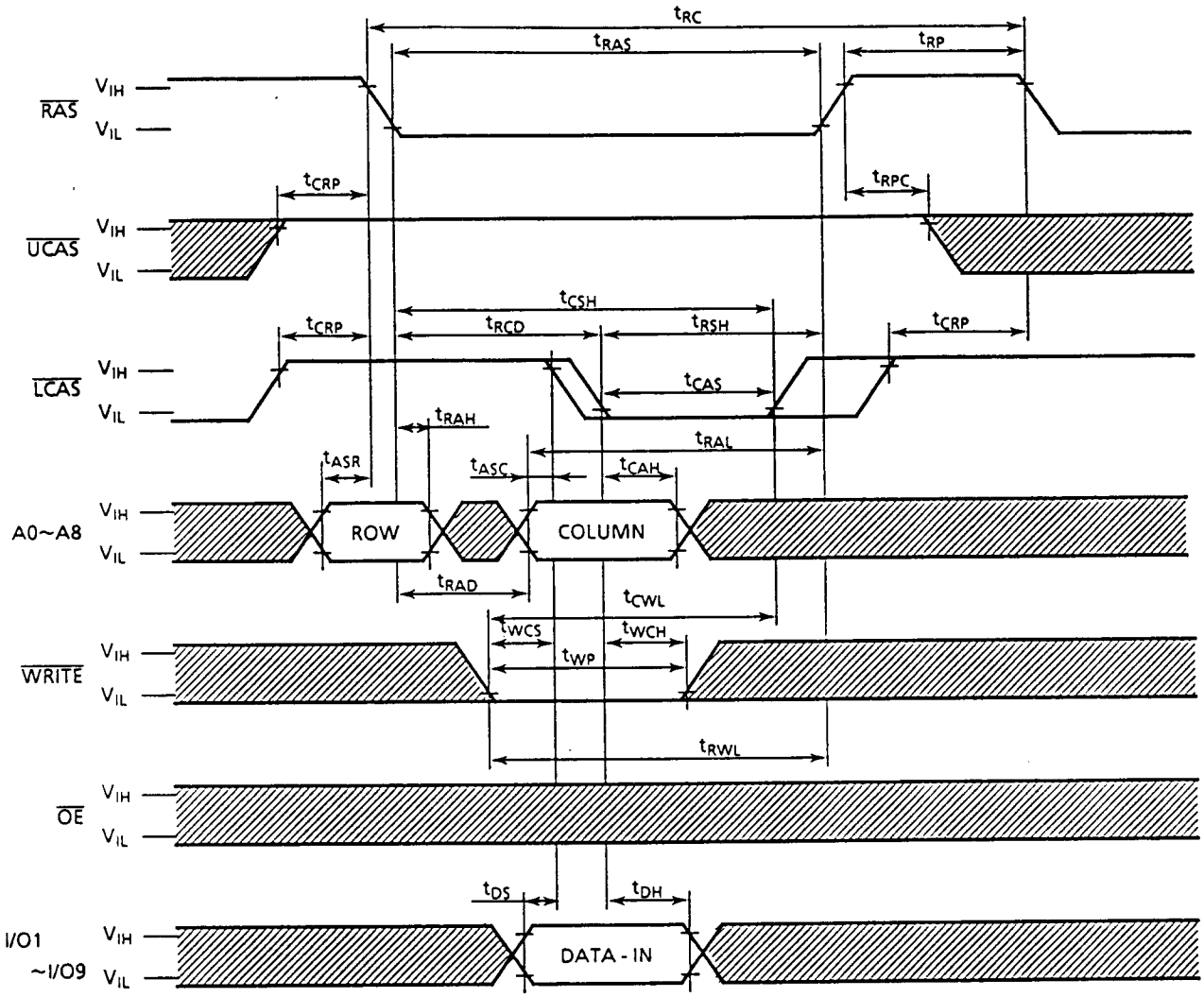
Note: D_{OUT} = OPEN

UPPER BYTE WRITE CYCLE (EARLY WRITE)



Note: D_{IN} (I/O1~I/O9) = Don't Care
D_{OUT} = OPEN

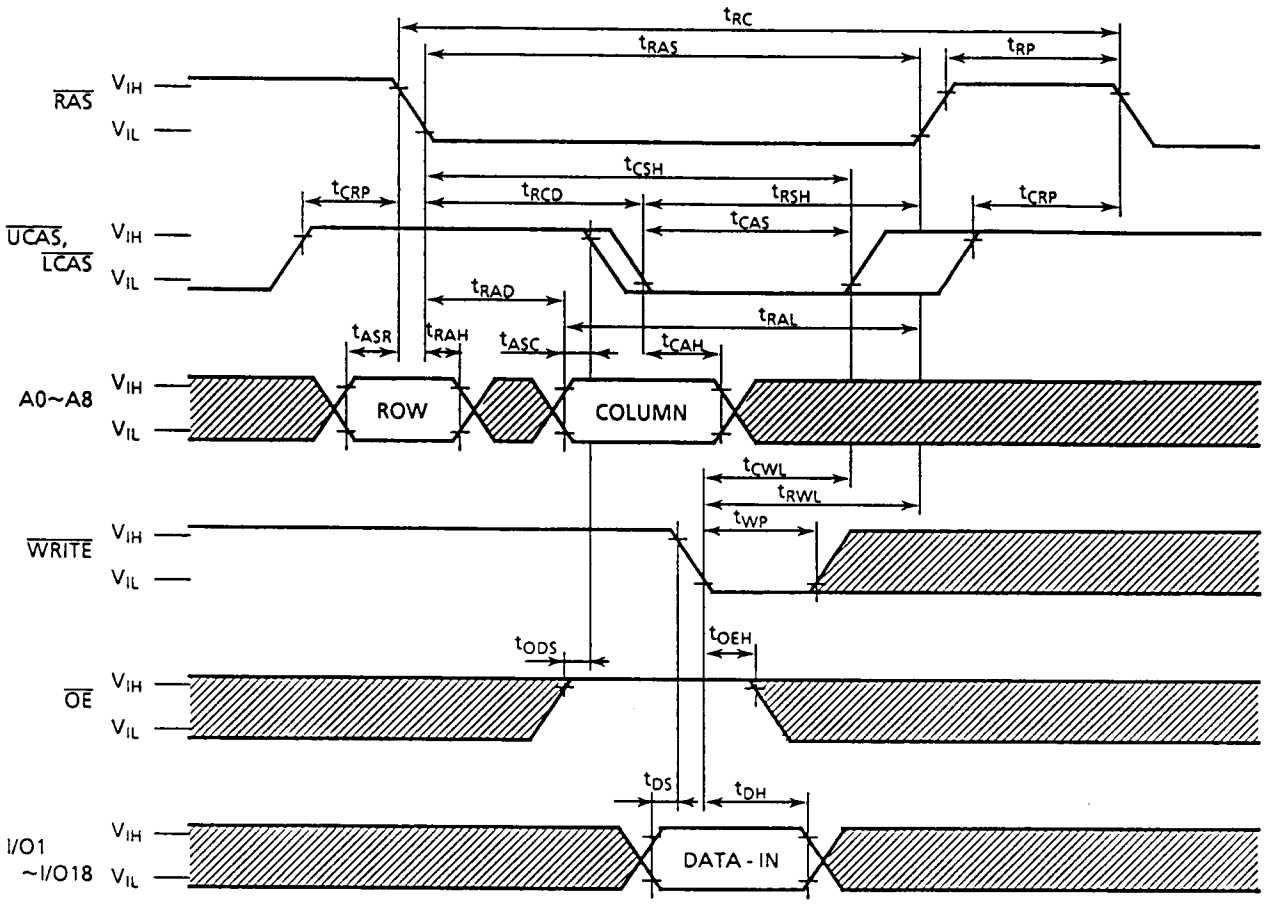
LOWER BYTE WRITE CYCLE (EARLY WRITE)



: "H" or "L"

Note: D_{IN} (I/O10~I/O18) = Don't Care
D_{OUT} = OPEN

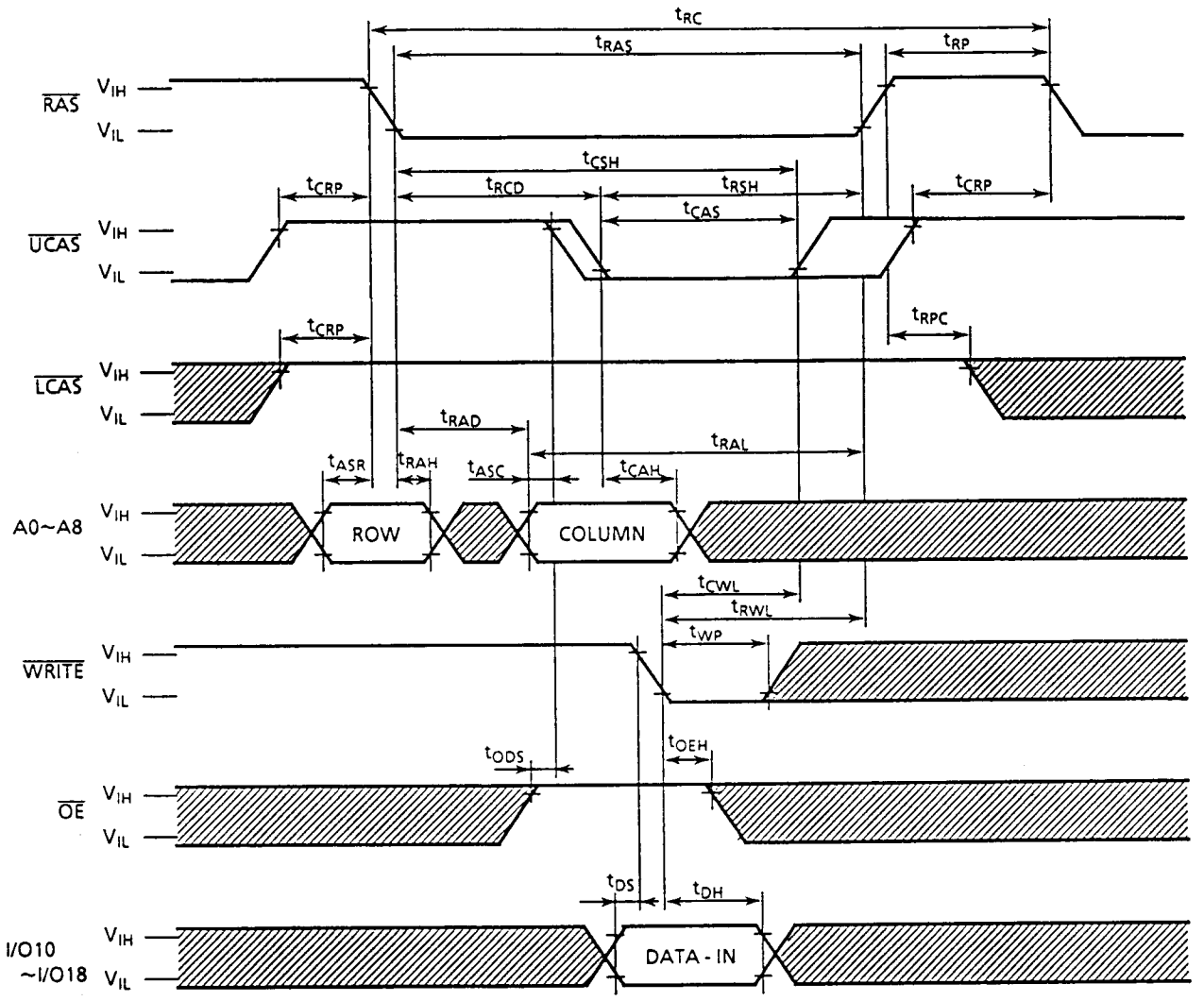
WRITE CYCLE ($\overline{OE}$ CONTROLLED WRITE)



Note: D_{OUT} = OPEN

▨ : "H" or "L"

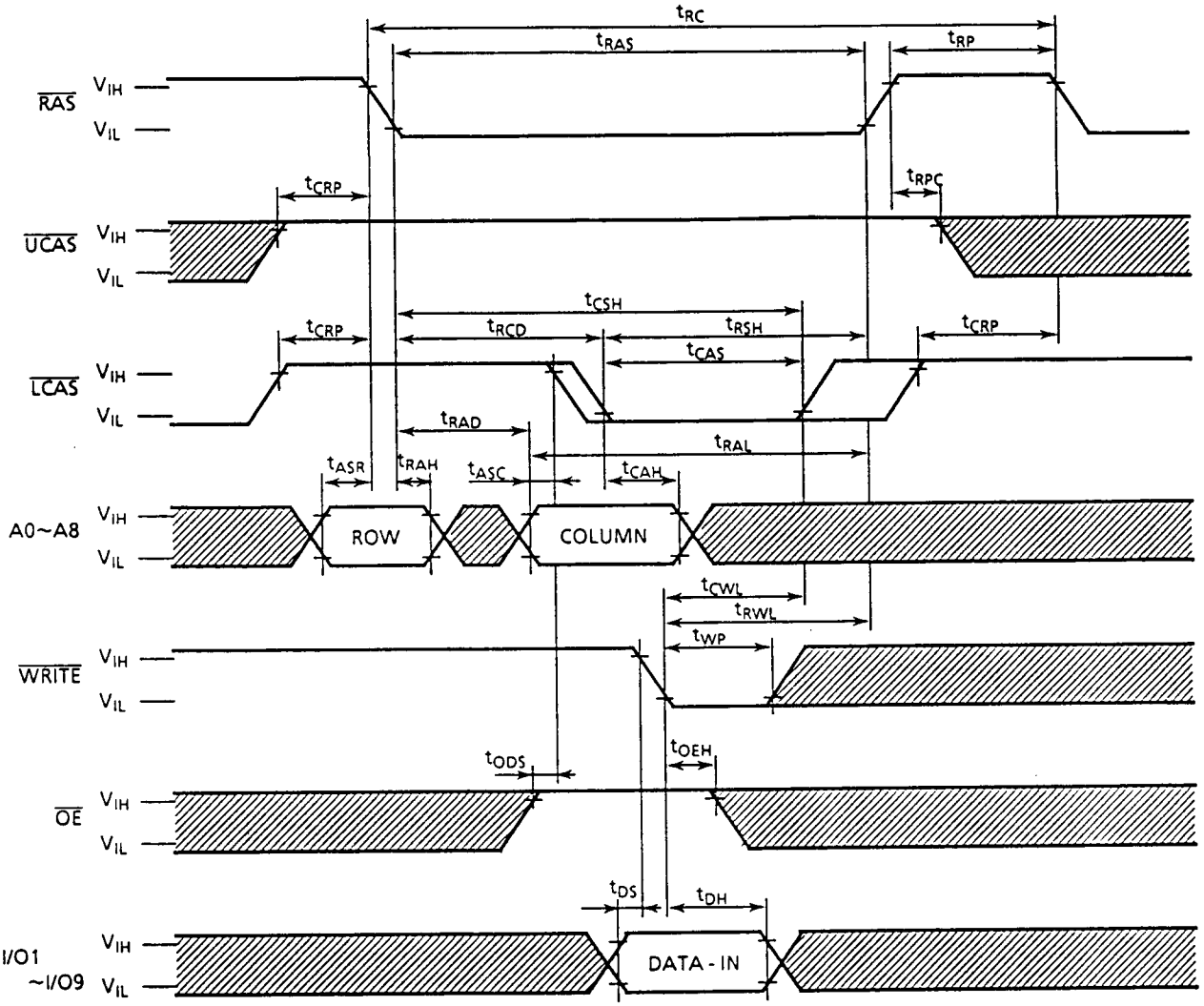
UPPER BYTE WRITE CYCLE ($\overline{OE}$ CONTROLLED WRITE)



Note: D_{IN} (I/O1~I/O9) = Don't Care
D_{OUT} = OPEN

▨ : "H" or "L"

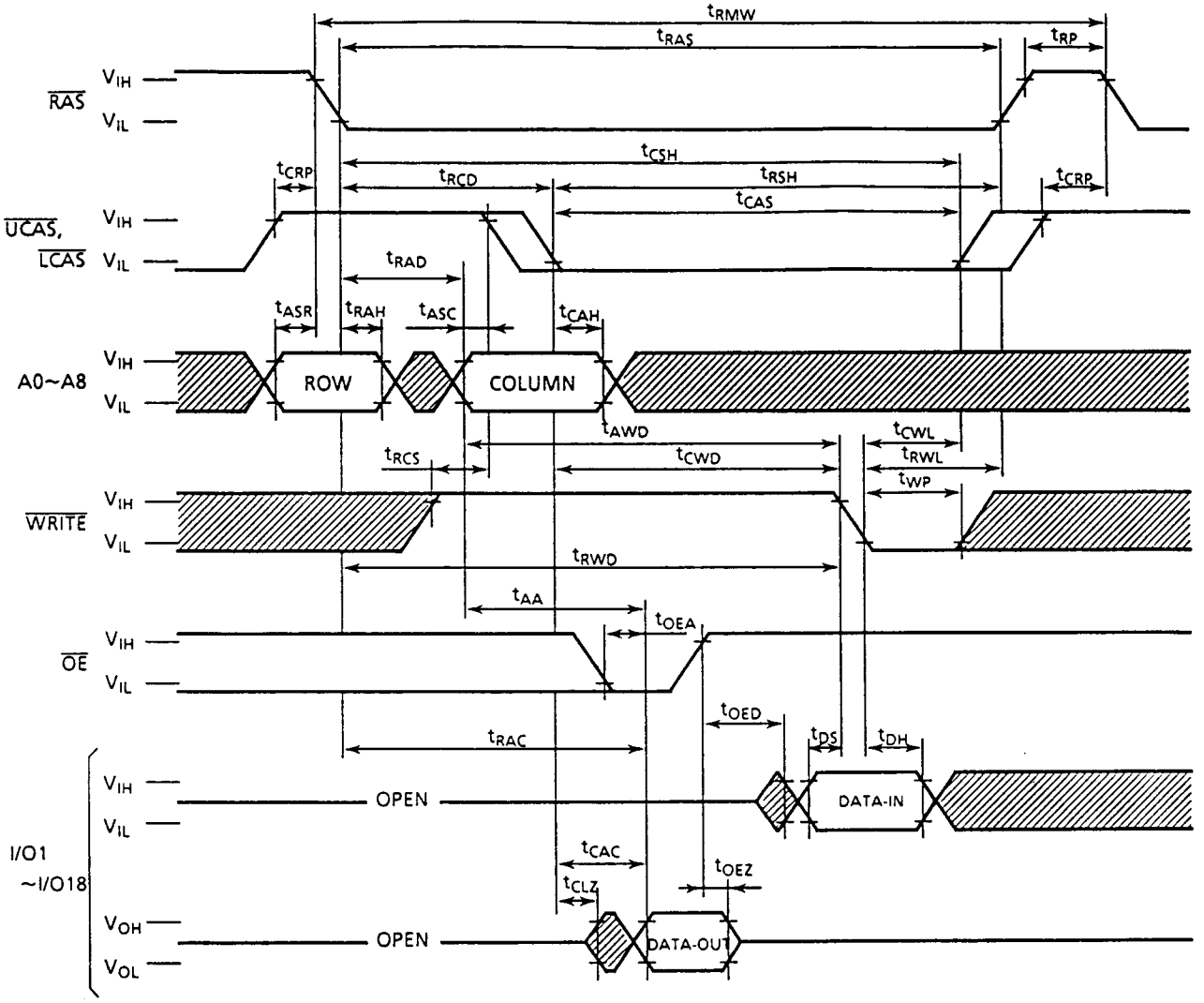
LOWER BYTE WRITE CYCLE ($\overline{OE}$ CONTROLLED WRITE)



Note: D_{IN} (I/O10~I/O18) = Don't Care
D_{OUT} = OPEN

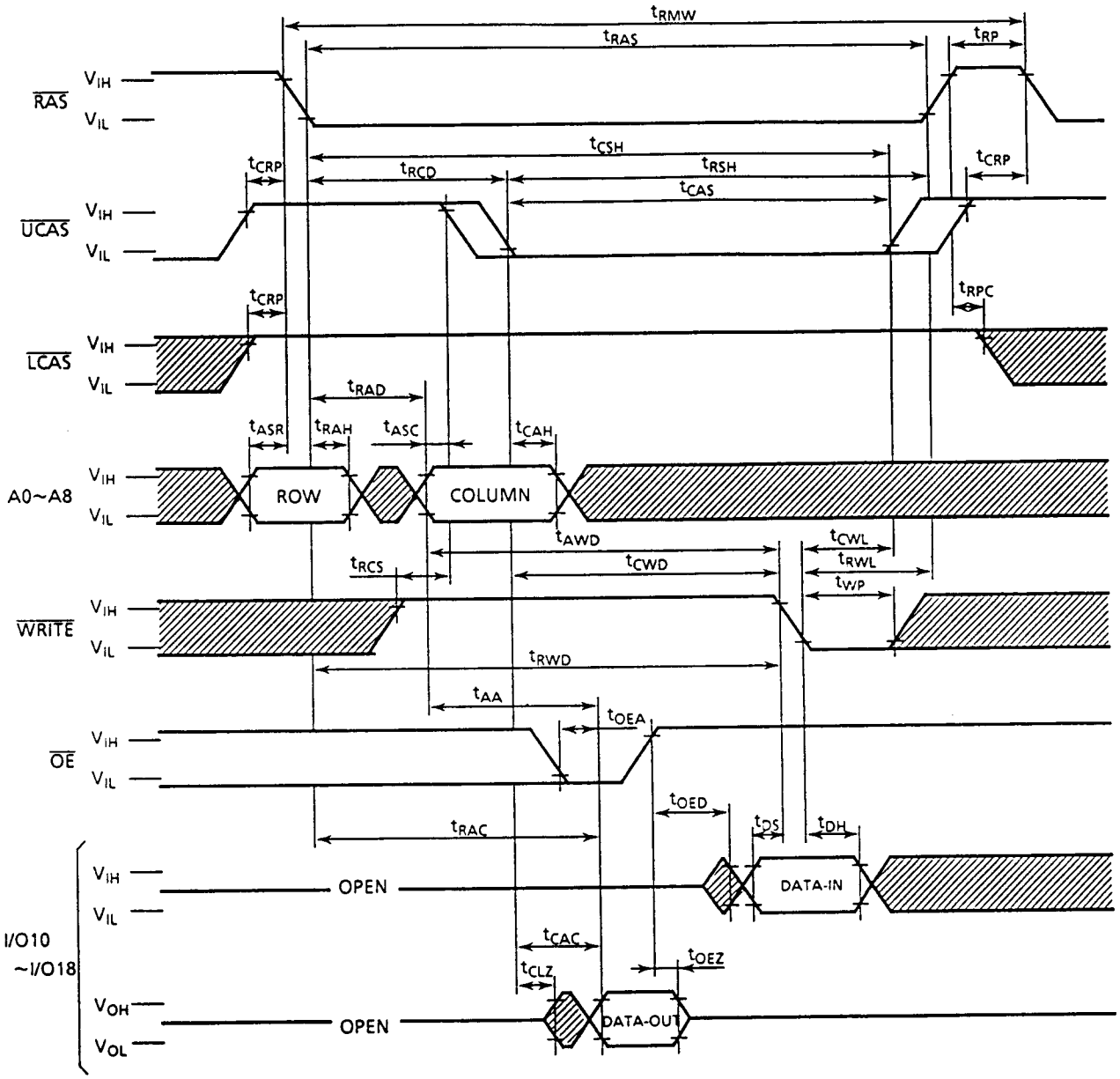
▨ : "H" or "L"

READ-MODIFY-WRITE CYCLE



: "H" or "L"

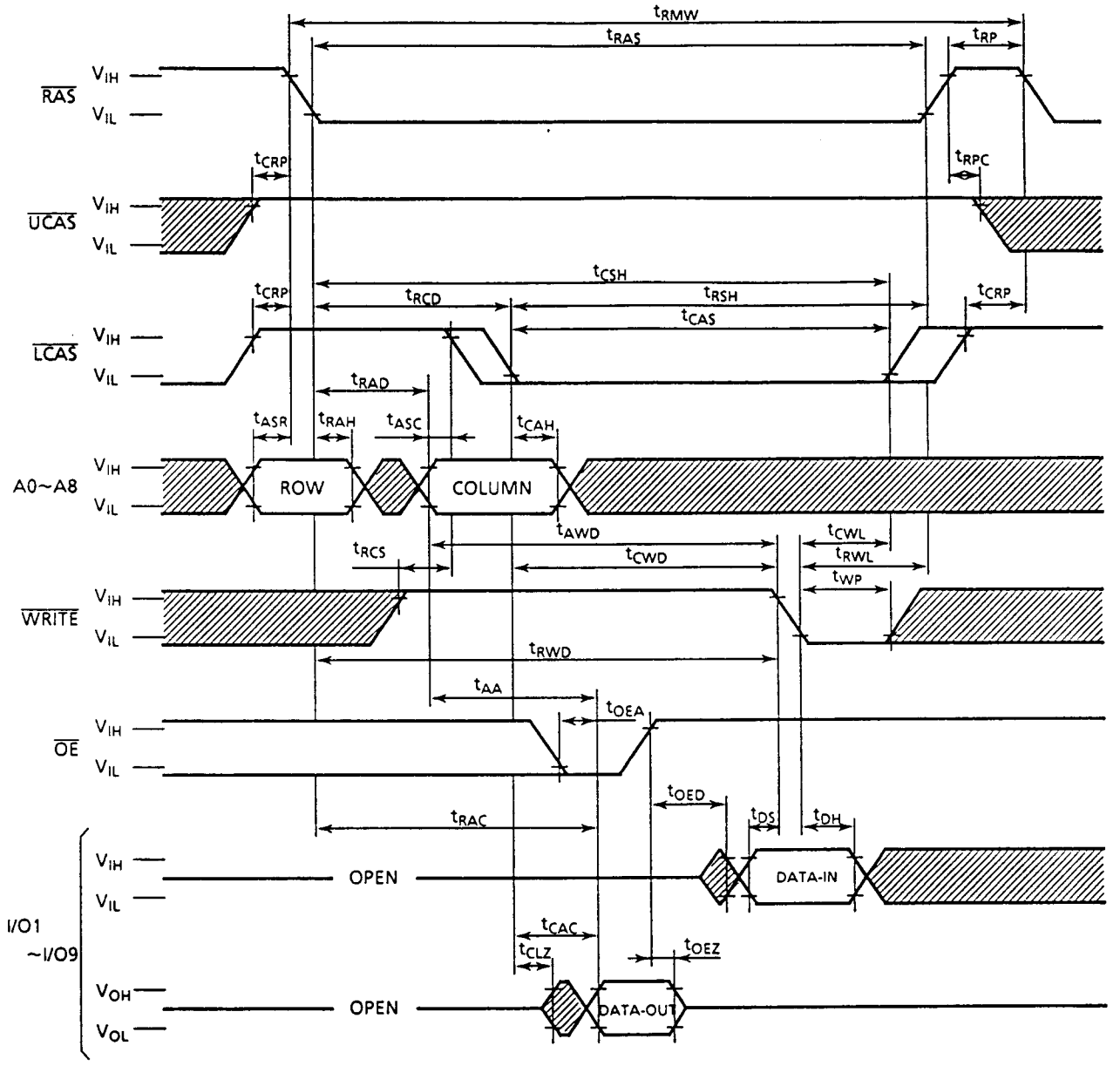
UPPER BYTE READ-MODIFY-WRITE CYCLE



: "H" or "L"

Note: D_{IN} (I/O1~I/O9) = Don't Care
D_{OUT} (I/O1~I/O9) = OPEN

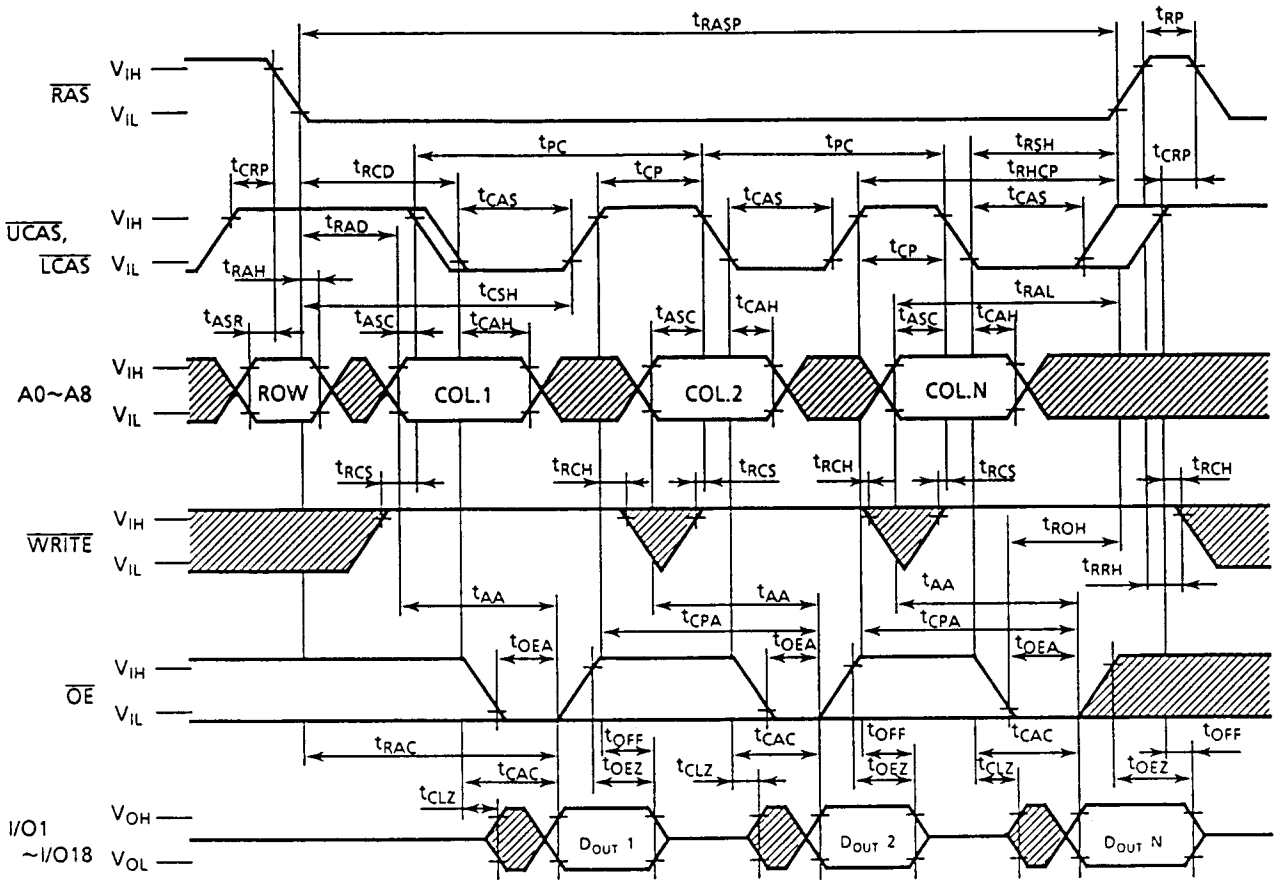
LOWER BYTE READ-MODIFY-WRITE CYCLE



: "H" or "L"

Note: D_{IN} (I/O10~I/O18) = Don't Care
D_{OUT} (I/O10~I/O18) = OPEN

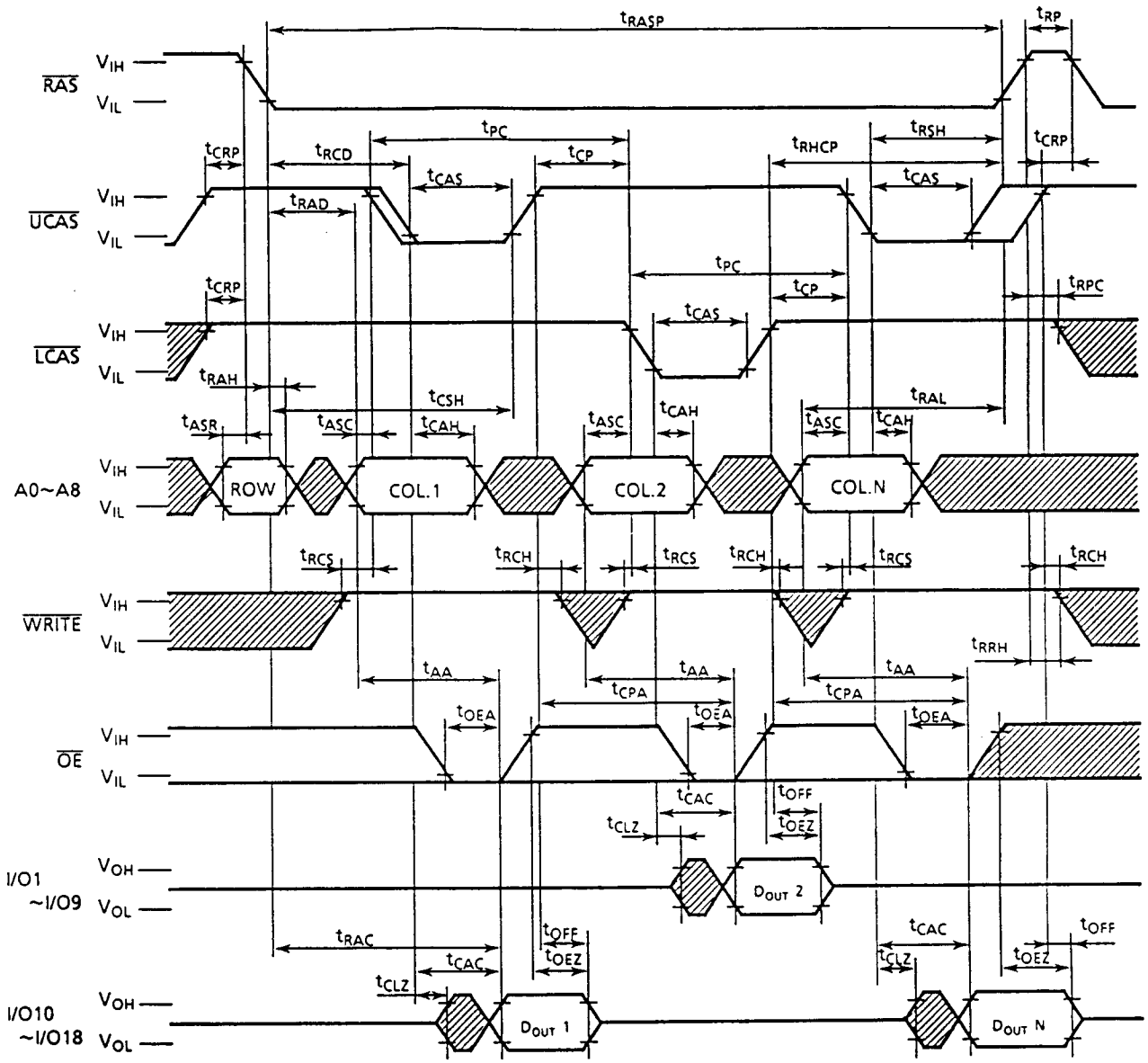
FAST PAGE MODE READ CYCLE



Note: D_{IN} = OPEN

▨ : "H" or "L"

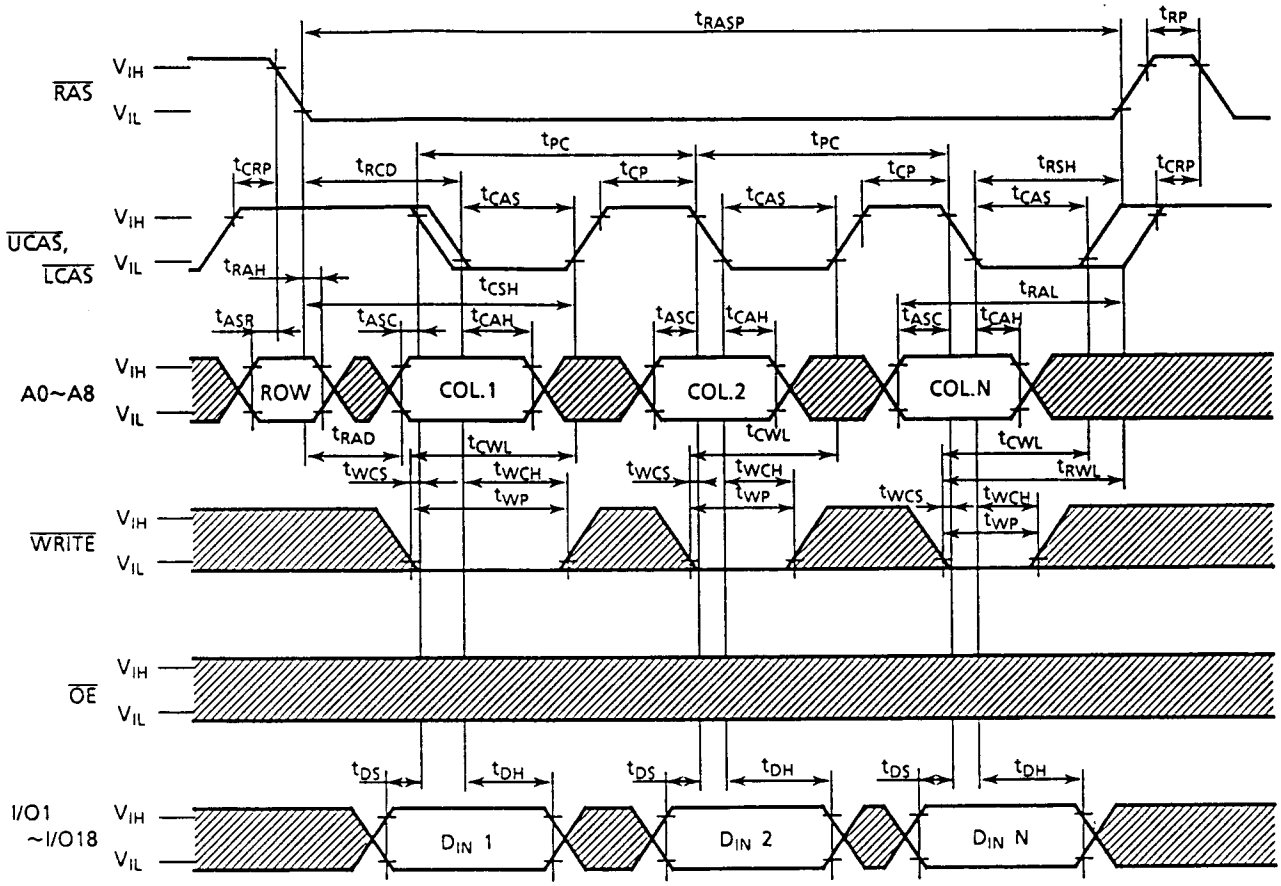
FAST PAGE MODE BYTE READ CYCLE



Note: D_{IN} = OPEN

▨ : "H" or "L"

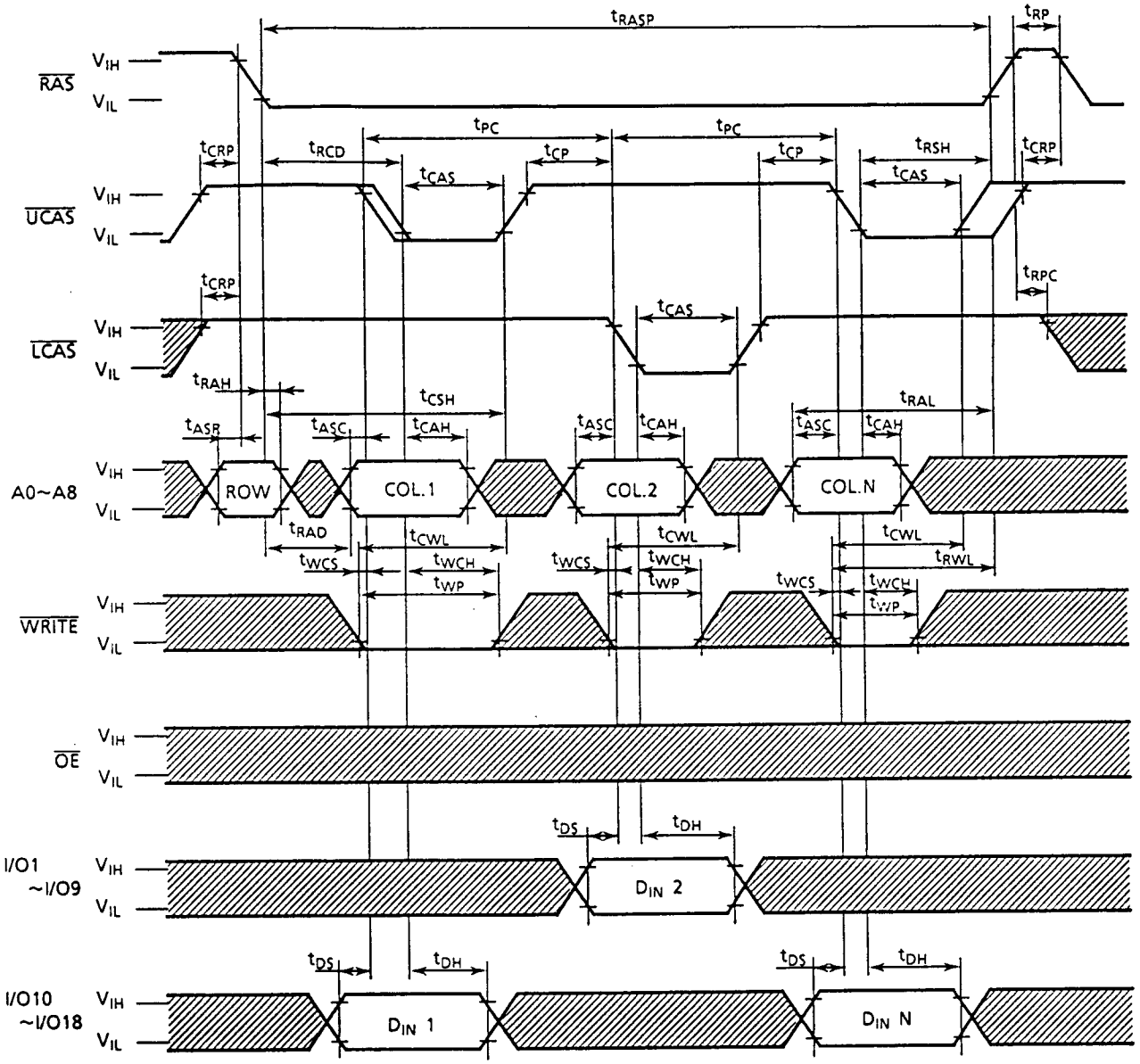
FAST PAGE MODE WRITE CYCLE (EARLY WRITE)



Note: D_{OUT} = OPEN

▨ : "H" or "L"

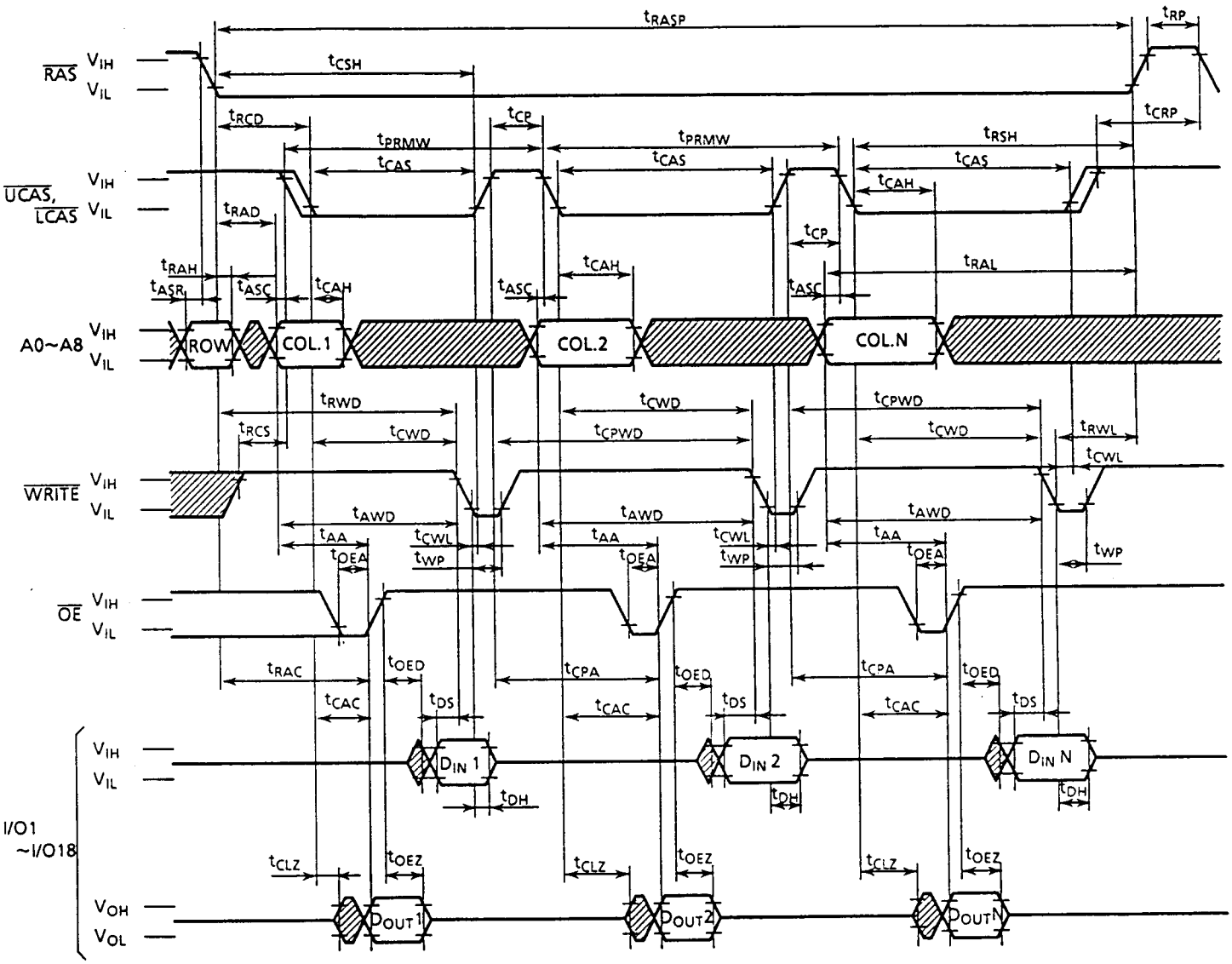
FAST PAGE MODE BYTE WRITE CYCLE (EARLY WRITE)



Note: D_{OUT} = OPEN

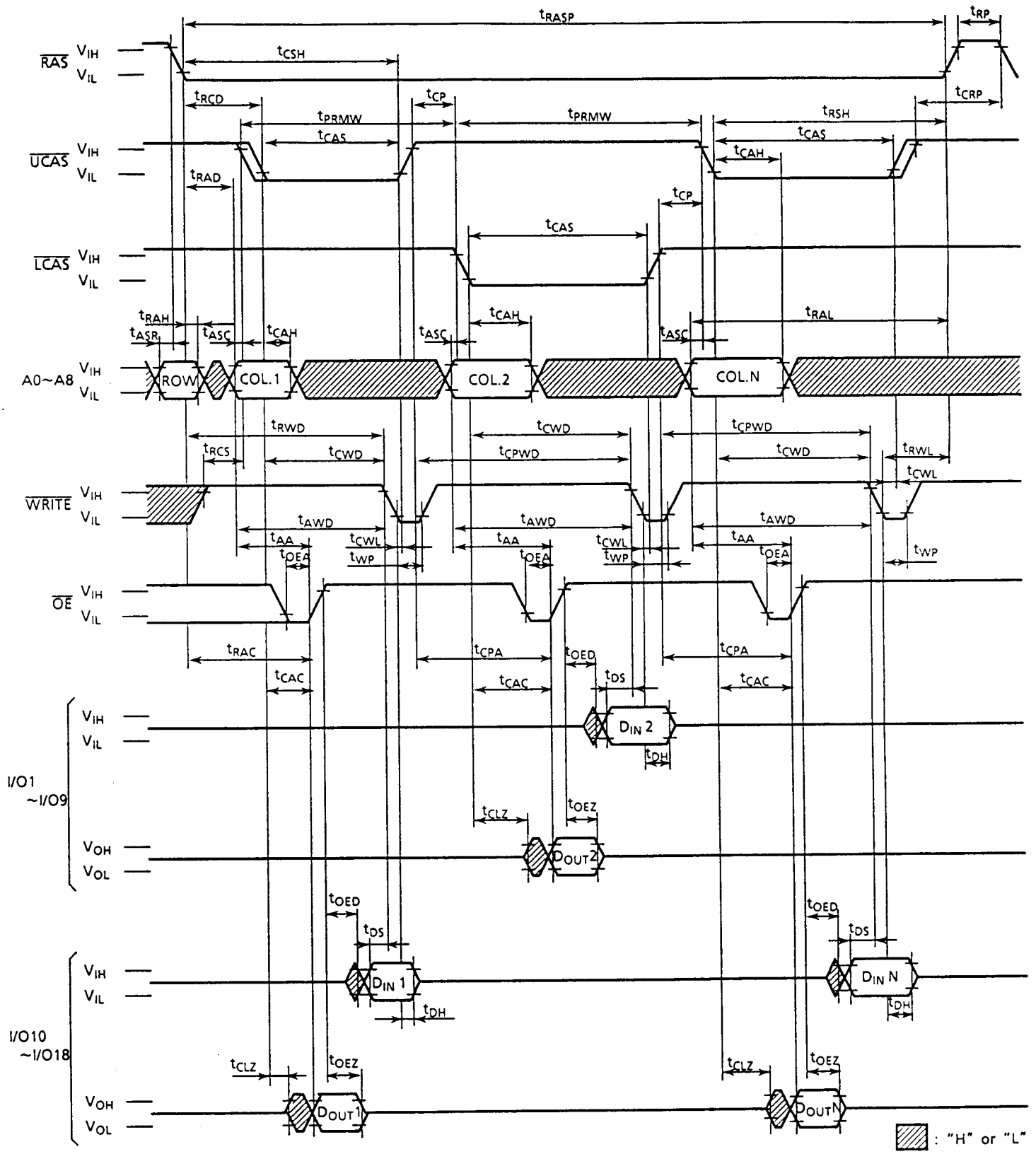
▨ : "H" or "L"

FAST PAGE MODE READ-MODIFY-WRITE CYCLE

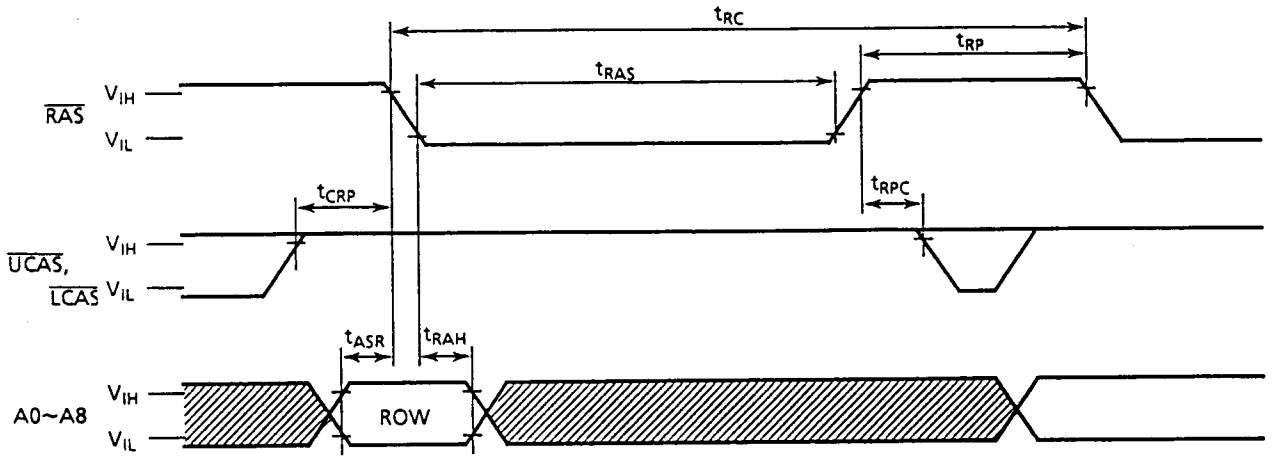


▨ : "H" or "L"

FAST PAGE MODE BYTE READ-MODIFY-WRITE CYCLE



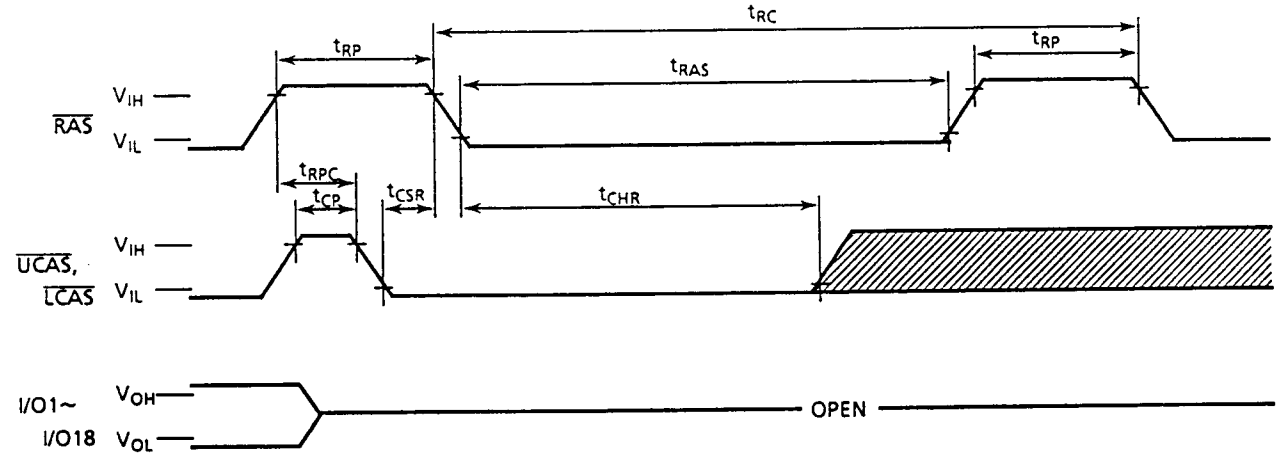
$\overline{RAS}$ ONLY REFRESH CYCLE



Note: $\overline{WRITE}$, $\overline{OE}$ = "H" or "L"
D_{IN} = Don't Care
D_{OUT} = OPEN

▨ : "H" or "L"

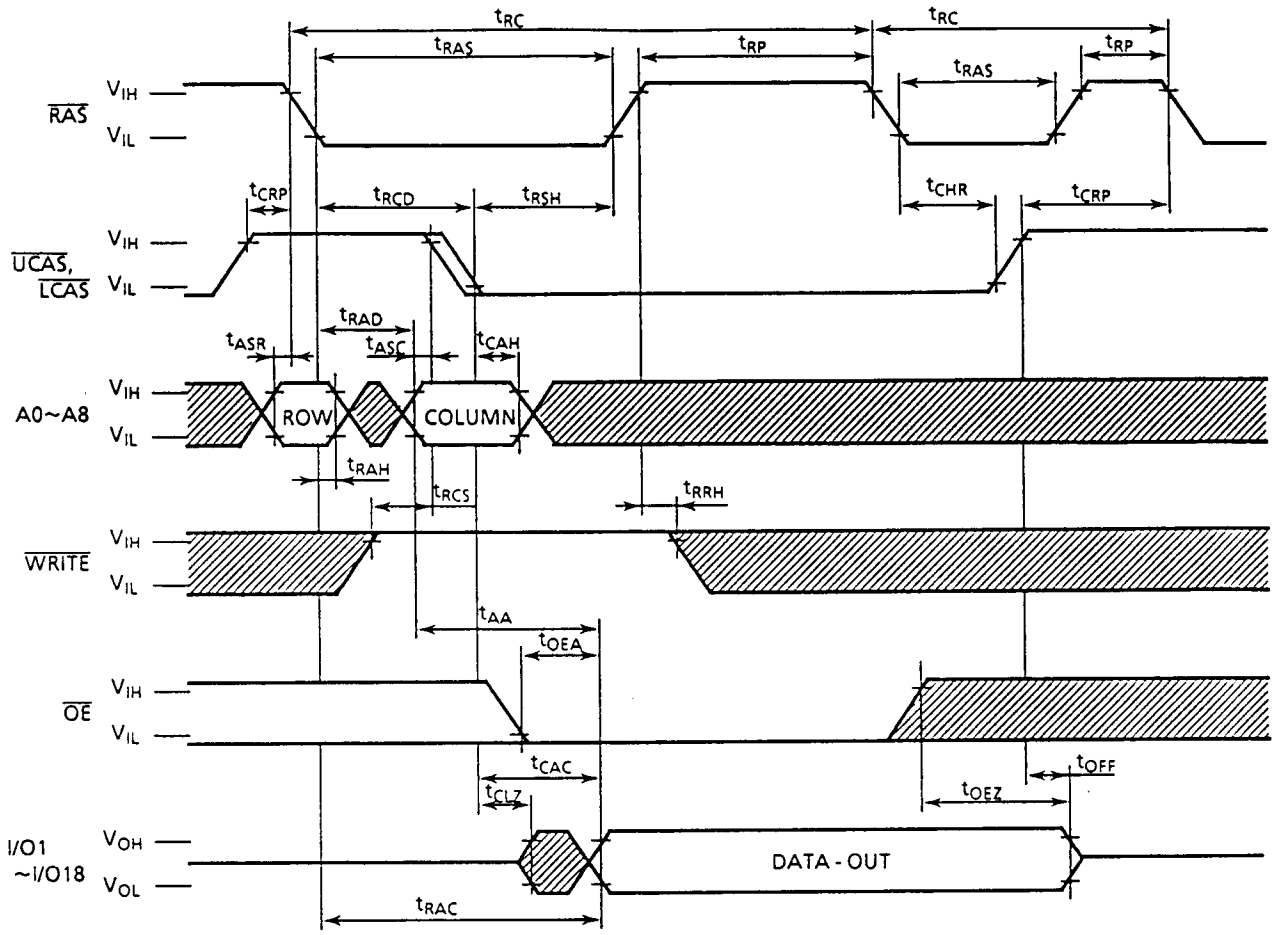
$\overline{CAS}$ BEFORE $\overline{RAS}$ REFRESH CYCLE



▨ : "H" or "L"

Note: $\overline{WRITE}$, $\overline{OE}$, A0~A8 = "H" or "L"
D_{IN} = Don't Care
$\overline{CAS}$ before $\overline{RAS}$ refresh is performed when either $\overline{UCAS}$ or $\overline{LCAS}$ meets this timing.

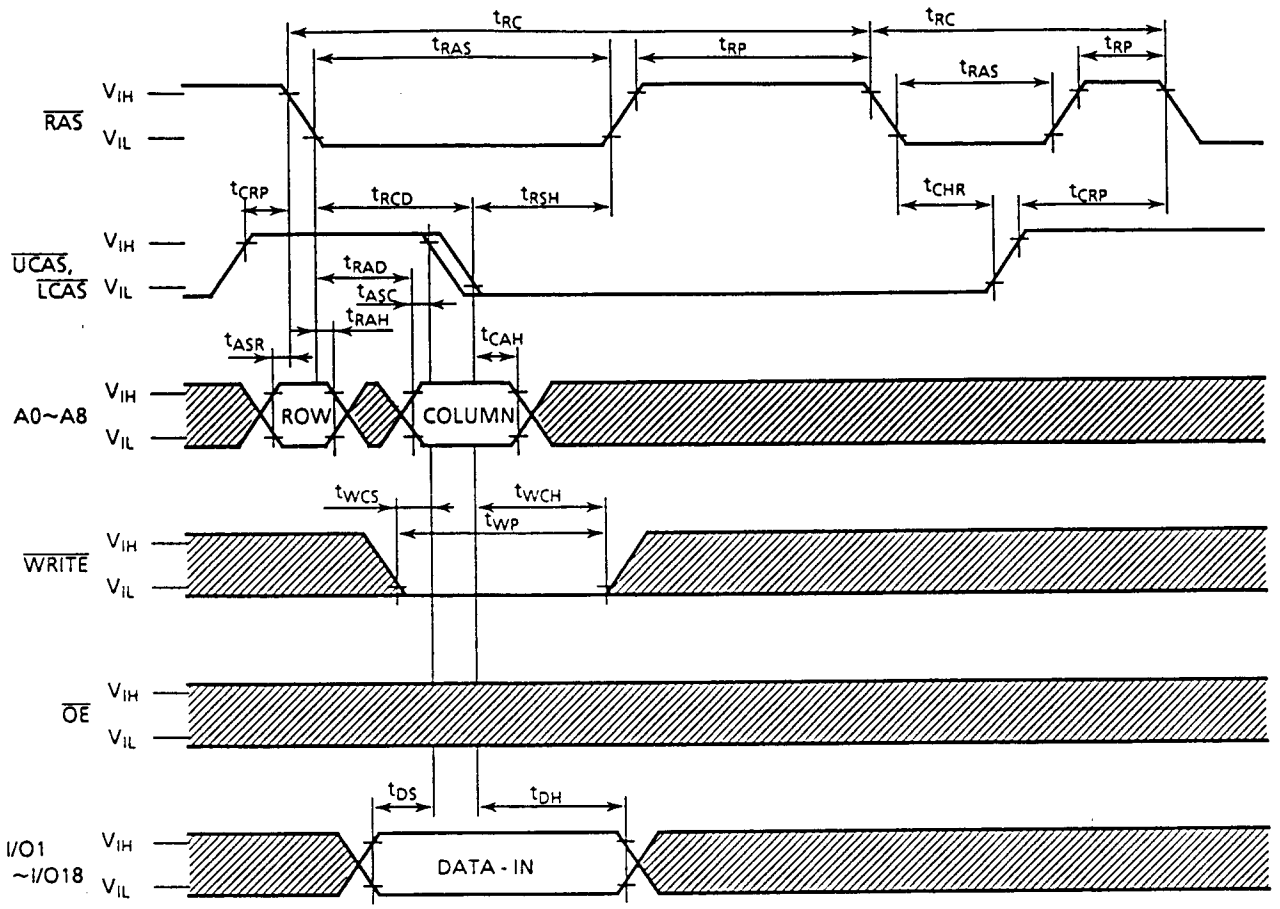
HIDDEN REFRESH CYCLE (READ)



Note: D_{IN} = OPEN

▨ : "H" or "L"

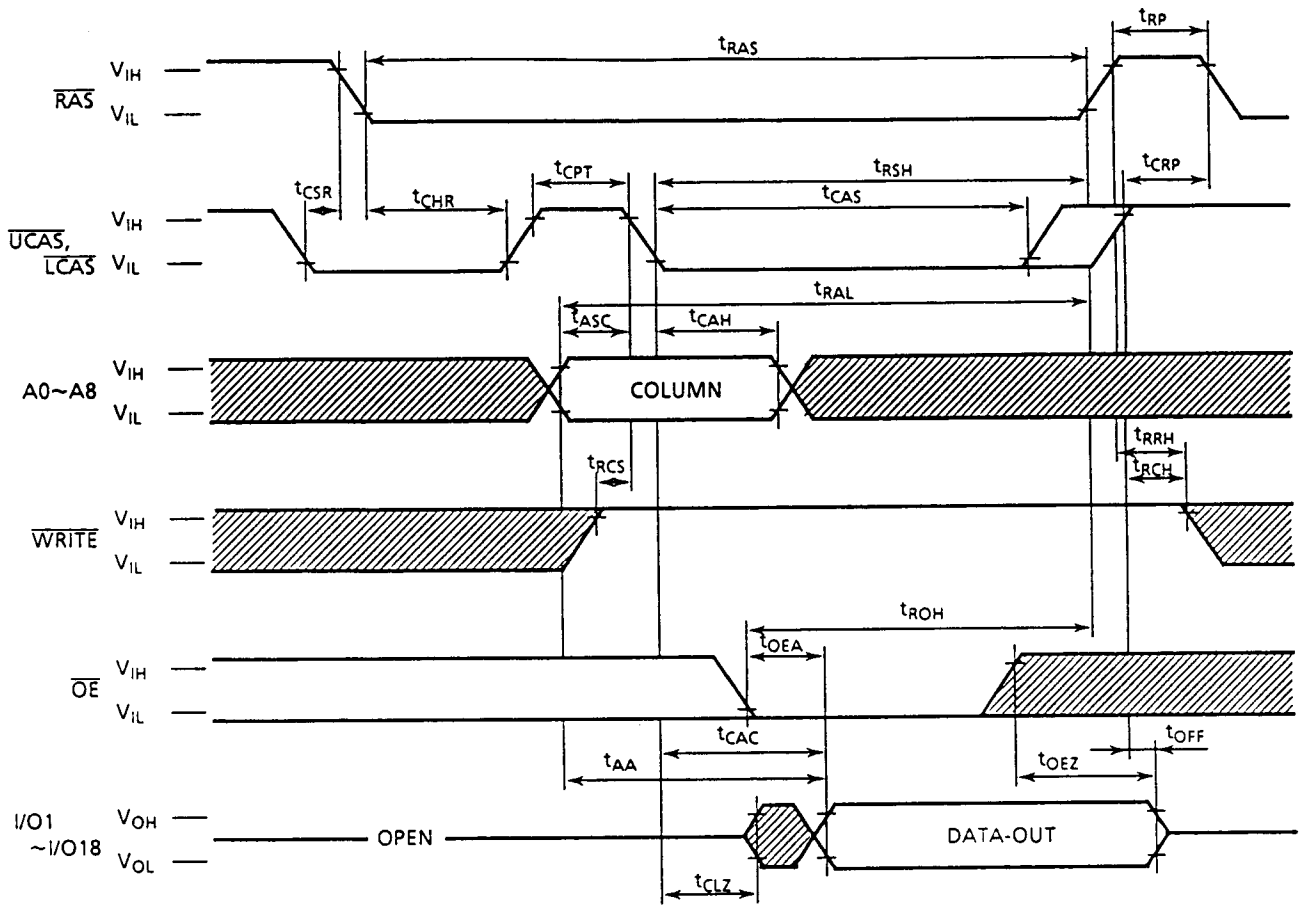
HIDDEN REEFRESH CYCLE (WRITE)



Note: D_{OUT} = OPEN

▨ : "H" or "L"

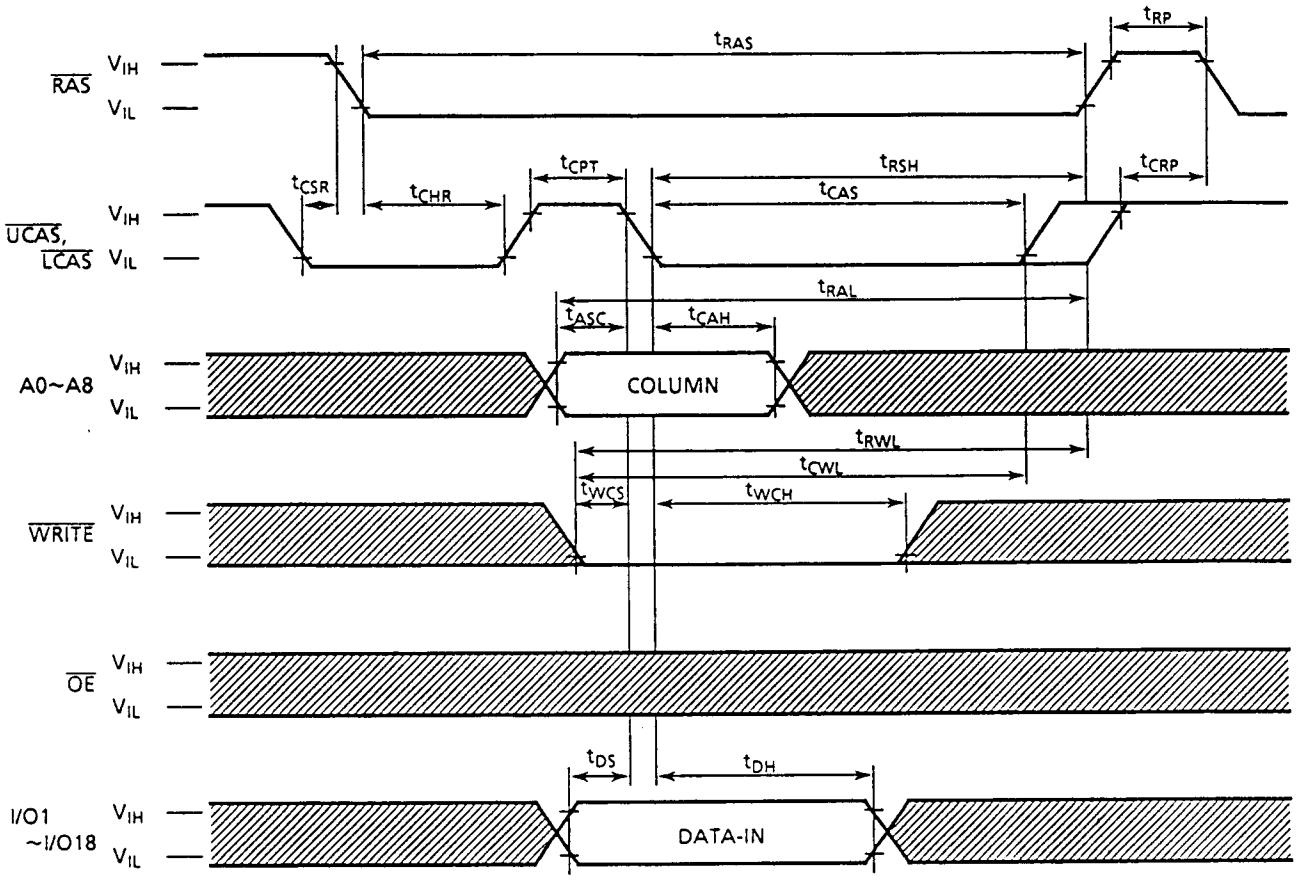
CAS BEFORE RAS REFRESH COUNTER TEST READ CYCLE



Note: D_{IN} = OPEN

▨ : "H" or "L"

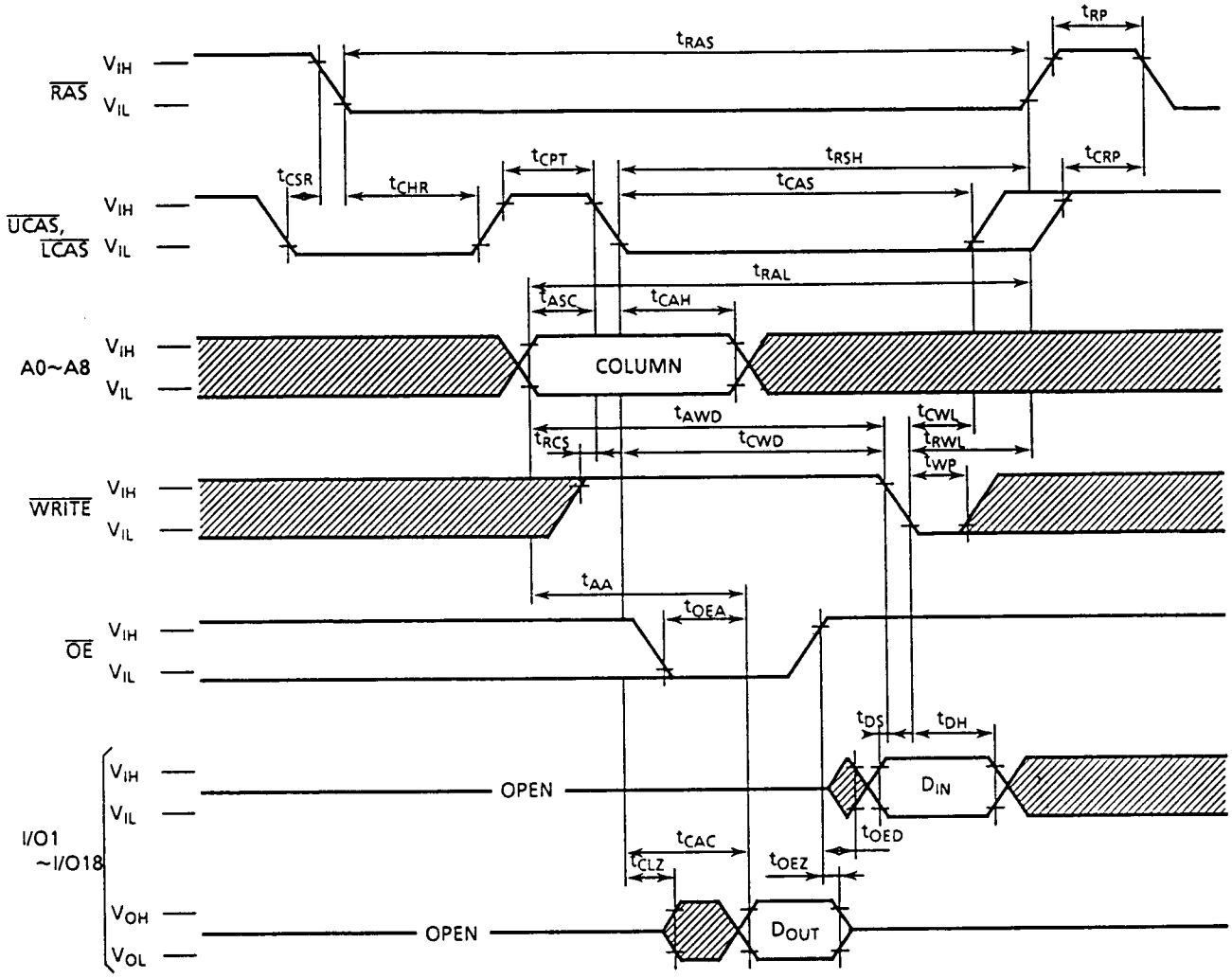
$\overline{CAS}$ BEFORE $\overline{RAS}$ REFRESH COUNTER TEST WRITE CYCLE



Note: D_{OUT} = OPEN

▨ : "H" or "L"

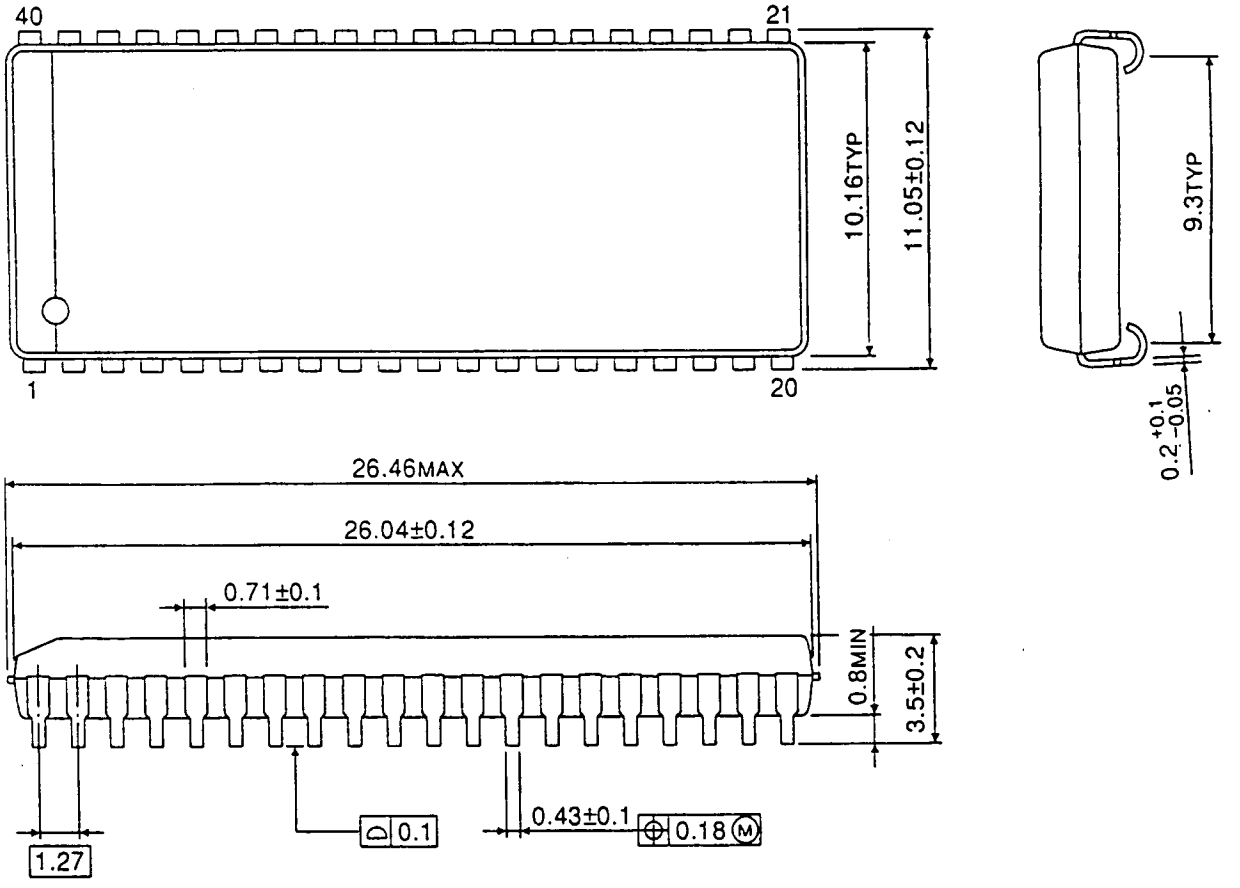
$\overline{CAS}$ BEFORE $\overline{RAS}$ REFRESH COUNTER TEST READ-MODIFY-WRITE CYCLE



: "H" or "L"

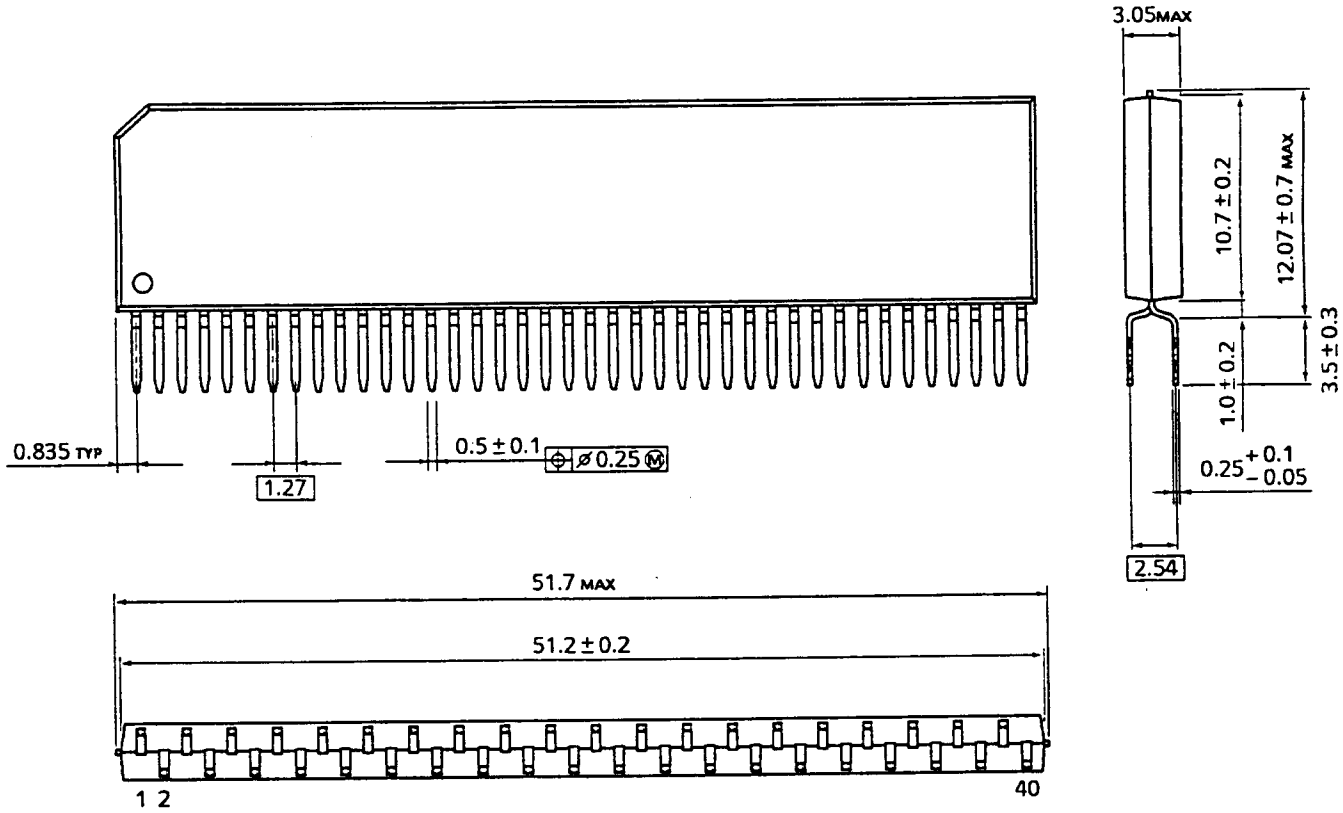
OUTLINE DRAWING (SOJ40 – P – 400)

Unit in mm



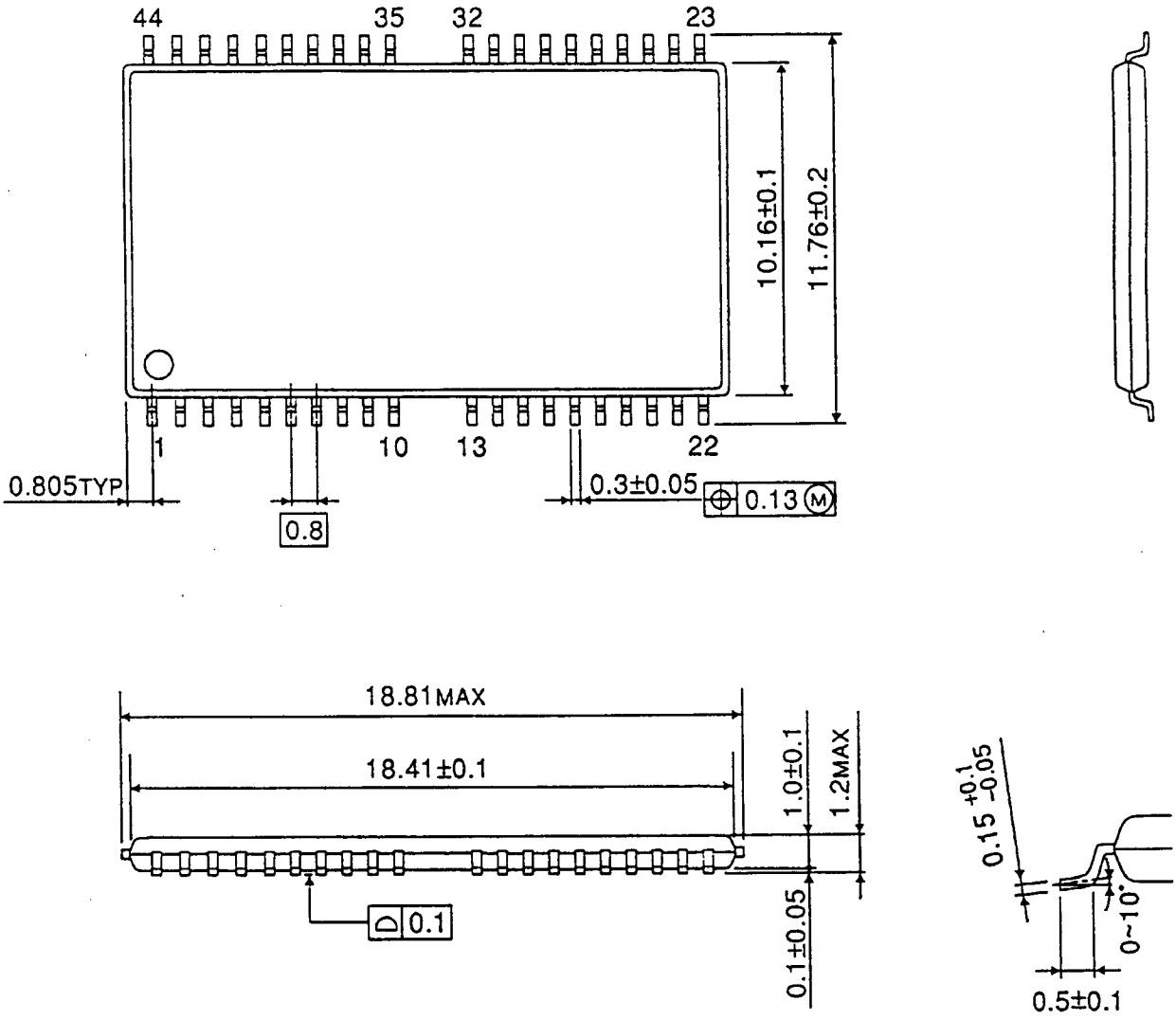
OUTLINE DRAWING (ZIP40 – P – 475)

Unit in mm



OUTLINE DRAWING (TSOP44-P-400B)

Unit in mm



OUTLINE DRAWING (TSOP44 – P – 400C)

Unit in mm